

ABSTRACT

RHONEY, BRIAN KEITH. Cylindrical Wire Electrical Discharge Truing of Metal Bond Diamond Grinding Wheels. (Under the direction of Albert Shih)

The goal of this research was to use the wire Electrical Discharge Machining (EDM) to profile a metal bond diamond grinding wheel, and then study the wear and grinding performance of the EDM trued wheel. Diamond wheels are known to exhibit low wheel wear for precision grinding of ceramics but create difficulty in creating precision trued forms. With the increased use of hard engineering ceramics in mechanical design, new methods of truing these wheels had to be investigated. In profiling a vitrified bond diamond wheel, a Computer Numerically Controlled (CNC) single point diamond or a diamond crush roll is often used. However, due to the high strength of the metal bond matrix, these methods cannot be implemented with a metal bond diamond wheel. Instead of applying a mechanical force, Wire Electrical Discharge Truing (WEDT) process utilizes electrical sparks to erode the metal matrix, which allows the non-conductive diamonds to simply fall away. A precision spindle was first built to rotate the wheel inside a traditional wire EDM machine. Once the process proved feasible, grinding studies were developed to compare the performance of a WEDT wheel against a diamond rotary trued/stick dressed wheel. Grinding force, surface finish of the ground silicon nitride parts, and wheel wear were all examined. The surfaces of both truing methods were compared using Stereo-Scanning Electron Microscopy to measure the protruding diamonds' height and identify the wear mechanism. Result of the research shows promise for the future use of WEDT as a truing method for metal bond wheels.

CYLINDRICAL WIRE ELECTRICAL DISCHARGE TRUING OF METAL BOND DIAMOND GRINDING WHEELS

by

BRIAN KEITH RHONEY

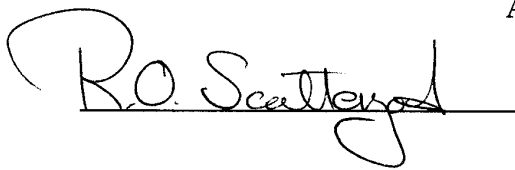
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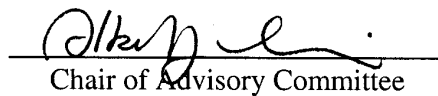
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DEDICATION

I would like to first thank the one who made this all possible, my Lord and Savior Jesus Christ. Without His ultimate sacrifice I would have no hope in life. Thank you for your faithfulness, love, and most of all patience through life's triumphs and tragedies. May all things that I do in life honor and glorify your name, for you are worthy of all my praise. "With man this is impossible, but with God all things are possible. (Matthew

I would also like to give a special thanks to my mother, Becky Rhoney. You're my rock; and your encouragement and guidance has meant more than you will ever know. Through all life's little bumps you were there to pick me up just so I could fall again. With much love, I thank you. To my family and friends I say, thanks for the past 23 years. I cannot think of better people to be with through this dance we call life.

BIOGRAPHY

Brian was born in Hildebran, a small town in the foothills of western North Carolina. Growing up he had two older sisters that loved to take care of him when he was young. His mother stayed at home as a caretaker until he was old enough to attend school. Brian's father loved being an outdoorsmen, but Brian chose sports instead. In middle school and high school he enjoyed playing sports and hanging out with his friends. Football, wrestling, and basketball were the sports of choice. In his senior year of high school, he loved math and science; so he decided to attend Appalachian State University to obtain a degree in Secondary Education. Throughout high school and into the first year of college, he worked as a German auto mechanic. In order to combine his love for science and math with his interest in the way things work, he changed his major to Engineering. In the Fall of 1997 he transferred to North Carolina State University in Raleigh, NC. From his first class in Engineering, he was sure that he had made the correct decision. After five semesters and two internships, he graduated Summa Cum Laude with a Bachelor of Science in Mechanical Engineering. During his internship at Cummins Technical Center, in Columbus, Indiana he found interest in a research project for graduate studies. Under the guidance of Dr. Albert Shih, Brian has spent the last three semesters working toward obtaining a Master of Science Degree in Mechanical Engineering. He conducted his research at Cummins Engine Company's Technical Center, Oak Ridge National Lab, and NC State University. He will be graduating in May and start work in the fiber optical cable industry with Corning Cable Systems in Hickory, NC.

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1 INTRODUCTION

Over the past two decades the use of ceramic components in engineering design has increased steadily. This increase has also developed a need for improving tolerances and material removal rates when grinding these ceramics. The ability to create a precise form in a superabrasive wheel has been identified as one of these needs.

1.1 History of the Use of Ceramics in Diesel Engines

Applications of ceramics in diesel engines began in the late 1970's. Research work was carried out under U.S. Army research contracts to develop adiabatic and minimum friction diesel engine that eliminate vulnerable cooling and liquid lubrication systems for military vehicles. While these diesel concepts did not move beyond the research stage, the programs highlighted the potential benefits that ceramics could provide in production engines. The actual usage of ceramics in commercial diesel engines evolved from these research efforts.

Due to the success of ceramic materials in selected applications, efforts are continuing to utilize ceramics in specialized applications. Efforts are now being focused on improving the cost effectiveness of precision ceramic components and improving the processing capabilities. Silicon nitride, Silicon carbide, and Zirconia ceramics have been commercially proven for wear applications in diesel engines.

One example of success for the use of ceramics in the diesel engine is in the fuel injector. Figure 1.1 shows a diesel fuel injector, which incorporated a silicon nitride check ball and two plungers into the design. Due to EPA regulations, there was a

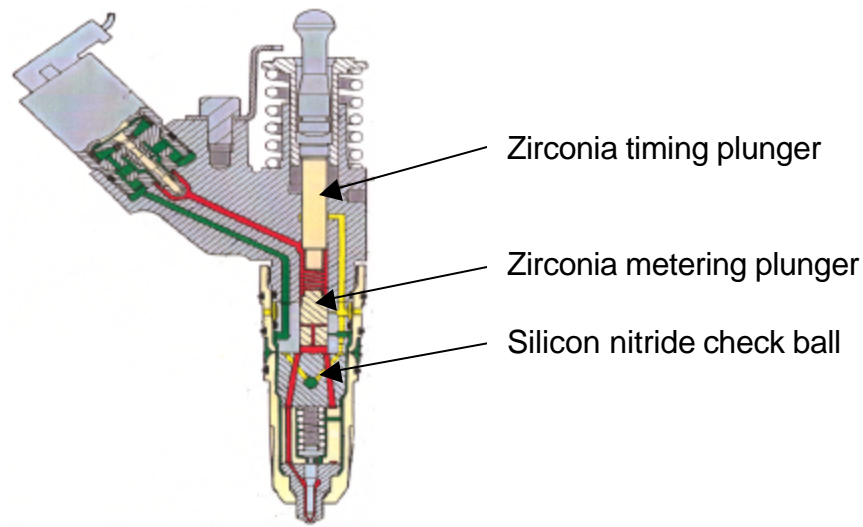


Figure 1.1: Fuel injector with ceramic components

decrease in the amount of lubricating sulfur that could be added to diesel fuel. To improve performance and reduce pollution, a high-pressure electronic injection system was developed. After these changes in the fueling system sticking between the steel plunger and barrel of the injector emerged. To eliminate the sticking problem and reduce the wear of the plunger, a ceramic plunger was implemented. Not only was there a savings in warranty cost, the ceramic component also created a product of higher reliability.

The future for ceramics in engines continues to be promising as machining technology advances and the resistance to ceramic usage diminishes. Advances in form grinding of advanced ceramics will allow these materials to compete on the basis of cost with such technologies as Titanium Nitride (TiN) coating of steel. Over time the geometry of the ceramic components have become more complex as shown in Figure 1.2. Due to a low coefficient of friction and excellent wear resistance, ceramic components are important to

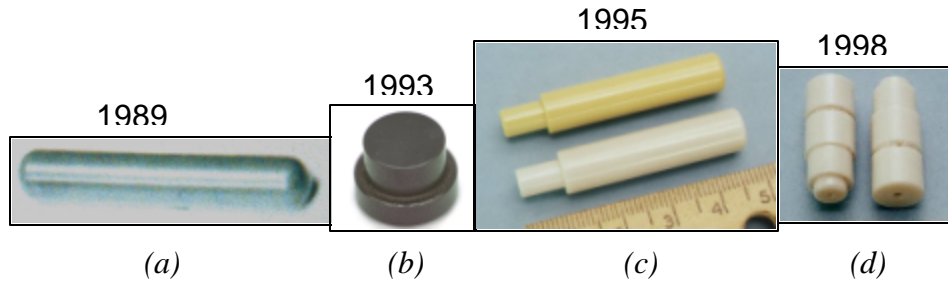


Figure 1.2: Evolution of ceramic grinding geometry
(a) Si_3N_4 Injector link (b) Si_3N_4 Pad
(c) Zirconia timing plunger (d) Zirconia metering plunger

the advancement of diesel engine technologies. However, steps must be taken to continue decreasing the machining costs, and increasing the ability to achieve tight tolerances while reaching high material removal rates for form ground ceramic components. WEDT provides a step in the direction of reaching this goal.

1.2 Form Grinding of Ceramics

Form grinding is used to reduce machining cost in many of cylindrical components. Currently, there are limitations to the precision that can be achieved through the forming and sintering of ceramics. Components require grinding to reach a final shape, and to attain the required tolerances. The form grinding process offers savings due to the decrease in the number of steps used to create a desired profile. As

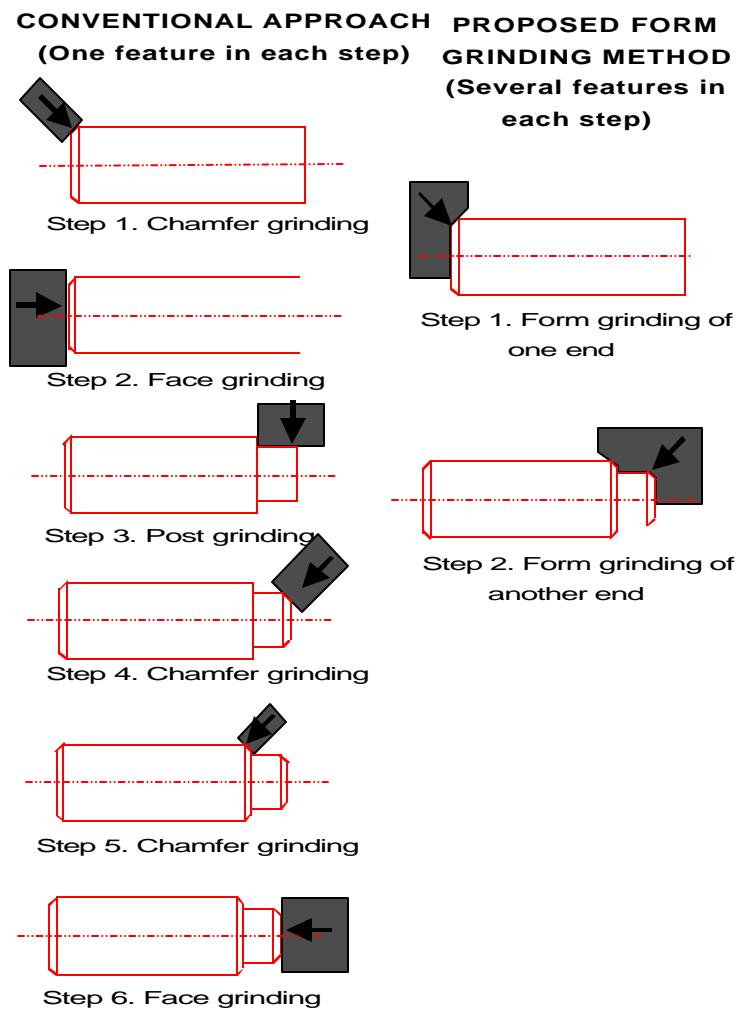


Figure 1.3: Comparison between conventional profile grinding and formed profile grinding

shown in Figure 1.3, a timing plunger can be machined using conventional or form grinding methods. With the conventional machining approach it would take six grinding setups to create the profile, while the form grinding method reduces this to two steps. Although this saves both time and money during grinding, it also produces another issue of creating a precise form in the grinding wheel.

The type of abrasive used in a grinding wheel is the determining factor on how well the wheel performs, and also how the wheel can be trued to a precise shape. Figure

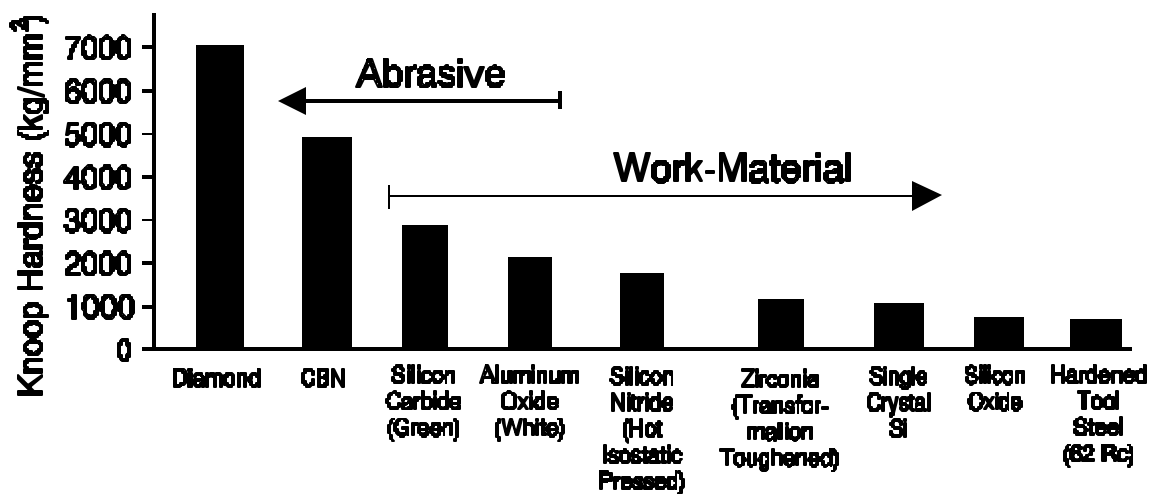


Figure 1.4: Chart of hardness of work materials and grinding abrasives

1.4 shows typical hardness values for both abrasive and work materials. Shih [2000] has reported advances in the use of silicon carbide in the grinding of zirconia. However, for other ceramic materials superabrasive wheels, such as CBN and diamond, must be used in grinding. The cost of CBN abrasive is double the cost of diamond abrasive.

Therefore, diamond is often used as the abrasive in grinding wheels for ceramic machining.

The three most popular grinding wheel bonding systems are: metal, resin, and vitreous. The use of vitreous bond wheels have grown rapidly because of their advantage of being trued and dressed simultaneously [Malkin, 1989]. However, the ability to create μm -scale precision form truing of the vitreous bond is difficult due to the excess wear of the truing tool [Shih, 1998]. Truing tool wear comes from the bonds high hardness and from the force required to shear the diamonds. In order to true an abrasive wheel effectively, the truing tool must be harder than the wheel being trued.

Precision forms are also unachievable with resin bond diamond wheels. This is due to the inability of the low strength bond to support the diamonds during truing. Metal bond wheels have good bond strength and wear characteristics, but create difficulty in truing and dressing capabilities. The solution is to change the truing method not the truing tool material [Shih, 2000]. WEDT can provide precise truing of metal bond diamond grinding wheels, without high mechanical forces that cause truing tool wear.

1.3 Basic Principles of Electrical Discharge Machining

The following description explains the theory behind the generation of spark erosion in the EDM process. While several theories of how EDM works have been advanced over the years, most of the evidence supports the thermoelectric model. The nine illustrations in Figure 1.5 are to show what is believed to happen during the generation of a single spark in the EDM process. Graphs at the bottom of each illustration show how the voltage and current change from each step. In all the diagrams, the wire electrode is the upper dark material of positive charge and the workpiece is the lower jagged part that is negatively charged. The dielectric fluid in the machining gap separates these two surfaces [Rajurkar, 2001].

Figure 1.5(a) shows what happens with the wire first comes near the workpiece. The dielectric fluid between them provides an insulator to keep electrical charge from flowing from one surface to another. However, as the potential difference increases between the surfaces, the dielectric fluid can break down and become ionic (electrically conductive). The electrical field is strongest at the point where the distance between the surfaces is minimal; thus the spark will occur at this location. Note the voltage has increased, but no current is flowing because of the presence of the dielectric fluid.

Next as shown in Figure 1.5(b), the number of ionic particles increases, making the insulating properties of the dielectric fluid begin to decrease along a narrow channel at the high point. Voltage will reach its peak, but current is still zero.

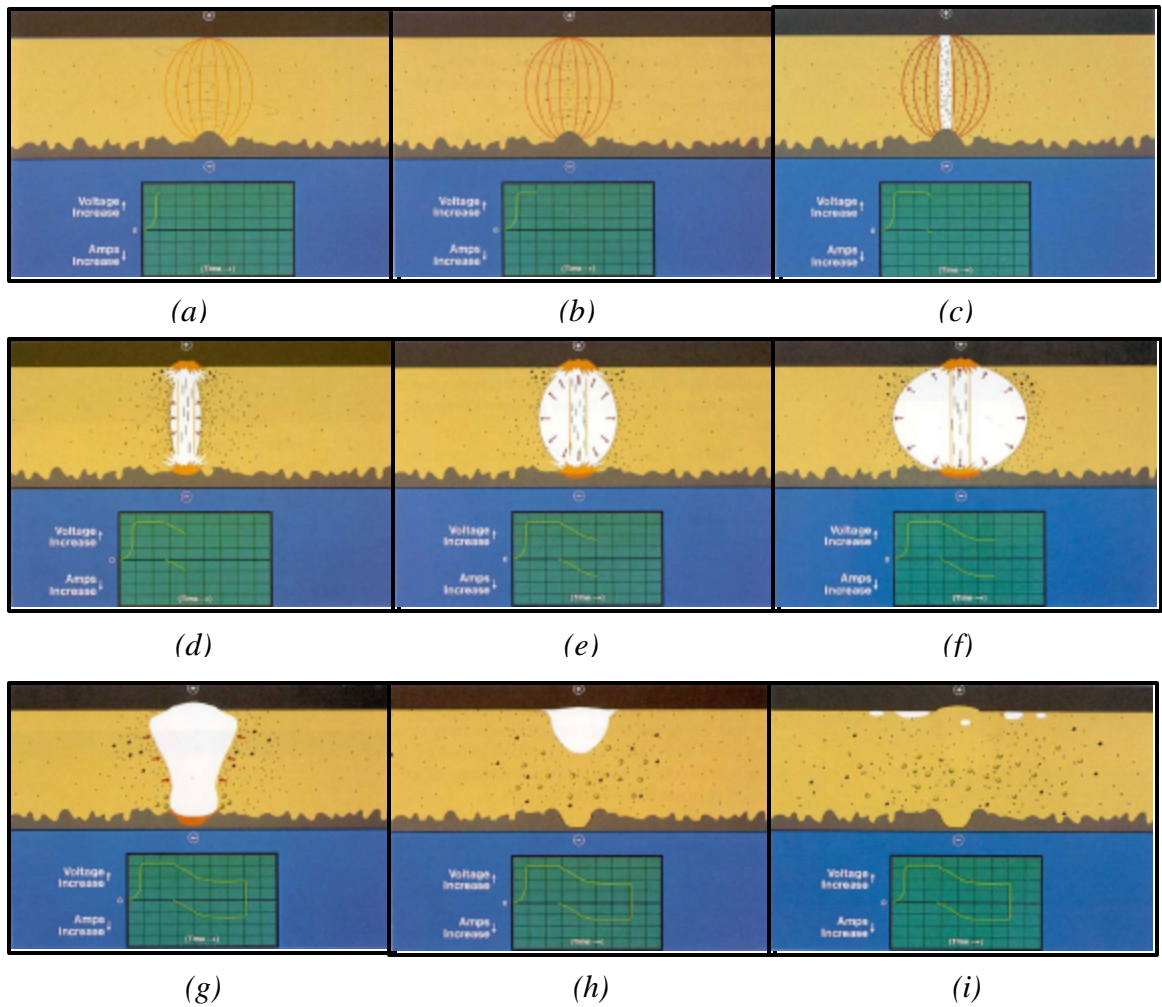


Figure 1.5: Evolution of a single spark in the EDM process [Rajurkar, 2001]

Figure 1.5(c) shows that a current has established, causing the voltage to decrease. Figure 1.5(d) shows that the voltage is continuing to drop as current continues to increase. The heat builds up rapidly, causing some of the fluid, workpiece, and electrode to vaporize. A discharge channel begins to form between the electrode and workpiece.

Figure 1.5(e) depicts a vapor bubble trying to expand outward, but a rush of ions towards the discharge channel limits its expansion. The intense electro-magnetic field that has built up in the channel attracts these ions.

Figure 1.5(f) is during the end of the time when the voltage is on. Here the current and voltage have stabilized. The heat and pressure inside the bubble have reached maximum and some metal is being removed. The metal directly under the discharge column is in molten state, but is held in place by the pressure of the vapor bubble.

Figures 1.5(g), 1.5(h), and 1.5(i) show what happens during the time when no voltage is applied. Both voltage and current go to zero, which causes the temperature and pressure to rapidly decrease in the vapor bubble causing it to collapse. This collapsing bubble allows the molten material to be expelled from the surface of the workpiece. Fresh dielectric fluid rushes in, flushing the debris away and quenching the surface of the workpiece. Unexpelled molten metal solidifies back to the surface to form what is known as the recast layer. This complete process of voltage on and off time comprises the EDM spark cycle.

Wire EDM, as shown in Figure 1.6(a), uses a traveling brass wire, ranging from 0.02 to 0.40 mm in diameter, as the electrode. Continuous electrical sparks, Figure 1.6(b), are generated between the wire and workpiece for material removal. By using computer numerical control, the thin wire is guided in the X and Y directions to cut a precise shape in the workpiece.

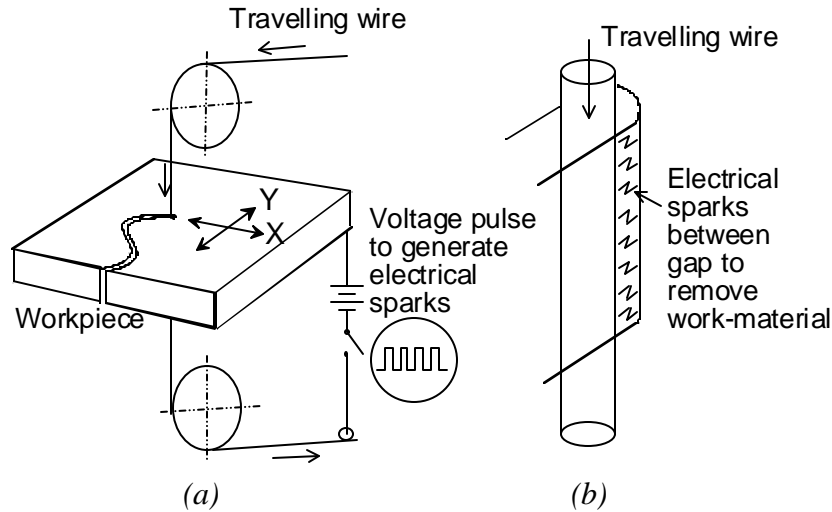


Figure 1.6: The wire EDM process, (a) conventional 2D wire EDM operation, (b) enlarged view of the wire and workpiece.

1.4 Proposed Truing Method for Metal Bond Diamond Wheels

Currently, there are two methods for creating a metal bond diamond wheel. One method uses a sintering process to combine metal powder and diamond to produce the formed wheel. This process creates a thick layer of diamond onto a solid metal core. Although effective in forming the wheel, currently the sintering process has limits on the ability to create precise forms. The alternative method uses a single layer of diamond electroplated on the surface of a preformed metal wheel [Malkin et al., 2000]. This technology, although cost-effective, has limitations on form accuracy, usually in the 15 to 30 μm range, and surface finish, typical above 0.3 μm average roughness. For parts that do not need μm -scale precision and fine surface finish, grinding with electroplated single-layer diamond wheels is the preferred choice.

If tighter form tolerances are required, then a method for creating precise forms in metal bond wheels is desired. The proposed method uses thermal energy instead of a mechanical force in order to true metal bonded wheels. The goal of this research is to use a 2-axis wire EDM machine to generate an intricate cylindrical form into the rotating metal bond diamond wheel, as shown in Figure 1.7(a). The grinding wheel is rotating around the B axis. As shown in Figure 1.7(b), the two slides control an electrically charged wire in the X and Y directions to generate a programmed trajectory on the rotating diamond wheel. Sparks between the wire and wheel erode the metal bond and create the desired cylindrical form, by allowing the non-conductive diamonds to fall away. The technical challenge of this concept is to achieve the μm -scale precision form tolerances of the diamond wheel.

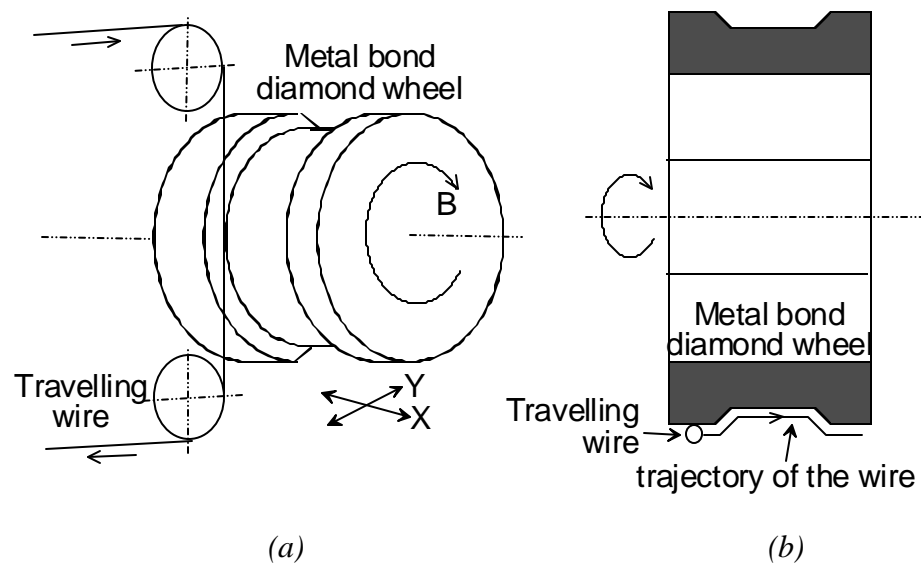


Figure 1.7: Wire EDM of metal bond diamond wheel, (a) configuration of the operation, (b) top view of the trajectory of the wire

1.5 Literature Review

Much research has been conducted on the EDM process over the past two decades. However, much of the work has been on developing better power sources, discharge patterns, and improving gap conditions. Most of the work being conducted with EDM truing has been conducted in Japan and China.

One of the first papers that discussed EDM truing was in 1987 by Suzuki et al. [1987]. This paper considers both wire and electrode EDM of metal bonded wheels. It discusses the problems associated with traditional truing of the hard metal bonded wheels. This paper shows evidence for a reduction in grinding forces, higher grinding ratio, and the realization of the ability to form wheels using EDM truing. The paper concludes with this statement, “The authors believe that this method will contribute to the development of grinding work with super abrasive wheels”. The details of the two truing methods die sinker and wire EDM, are summarized in the following sections.

1.5.1 Die Sinker EDM Truing Method

In die sinker EDM a graphite, copper, or tungsten electrode is shaped to perform the EDM process. The electrode is machined using conventional machining, such as milling and turning. Then the shaped conductive electrode is used to erode the contour into a workpiece through electrical sparks. A major disadvantage to this method is electrode wear, which creates error in the final component. The advantage is that machining occurs over the entire electrode surface, creating a high machining efficiency. On the contrary, with wire EDM the machining occurs at a single point, which is not as

efficient. However, due to electrode wear in the Die Sinker configuration, the ability to create precise forms is in question.

Suzuki's proposed electrode truing method compensates for this electrode wear by having a cutting tool that is used to shape the truing electrode. Figure 1.8 shows the method used for truing one of the metal bonded wheels. First the computer numerically controlled cutting tool is used to machine the desired profile into the electrode, Figure 1.8(a). Then EDM occurs, Figure 1.8(b), between the formed electrode and grinding wheel, which places the reverse profile into the wheel. Figure 1.8(c) shows that the worn electrode being reshaped to regain form tolerance. Then the finish EDM process occurs

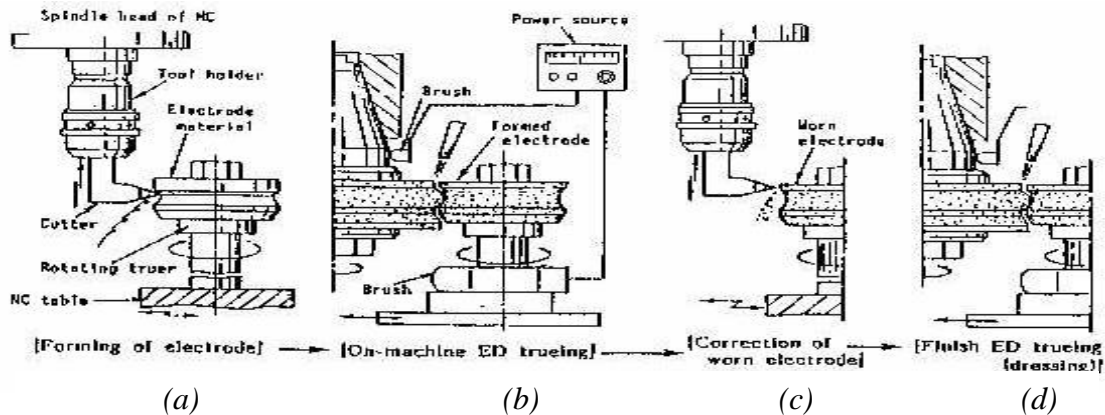


Figure 1.8: Procedure for formed electrode ED truing method [Suzuki, 1987]

to give the wheel its final shape, Figure 1.8(d). The advantage to this method is again that the electrode and wheel are the same width, thus truing time is reduced. However, with electrode wear occurring the accuracy of the form is in question.

Recent work has been conducted by Wang et al. [2000] to quantify the performance of die sinking EDM dressing. Parameters such as truing current, pulse

frequency, pulse duration, wheel speed, and wheel eccentricity were characterized on how truing efficiency was affected. However, the relationship between form accuracy and these parameters was never developed. This is in part due to the fact that form errors, in this rotary die sinking EDM, are dominated by electrode wear.

1.5.2 Wire EDM Truing Method

To eliminate the problem with electrode wear, a continuously feed wire can be used as the electrode. Suzuki's proposed wire EDM Truing method uses a ceramic guide to position the wire for machining, as shown in Figure 1.9. This setup creates more accurate profiles by eliminating electrode wear effects. However, the process is difficult to implement due to the specialized equipment used for the truing process.

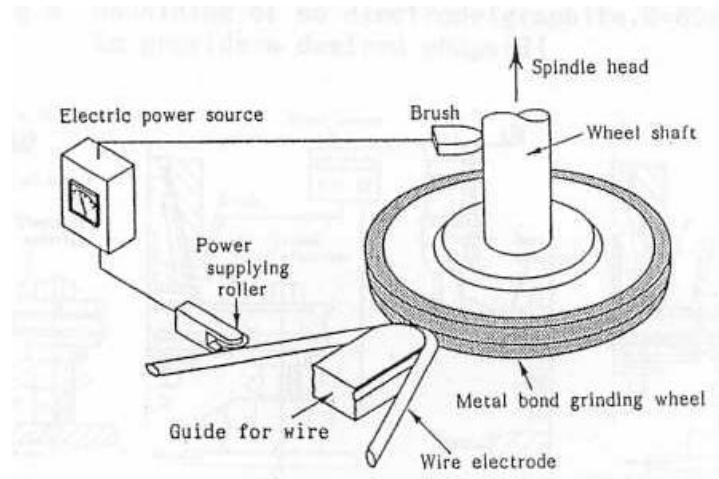


Figure 1.9: Wire EDM truing/dressing method [Suzuki, 1987]

It would be desirable to be able to perform this operation on a standard wire EDM machine. The proposed WEDT method which this thesis details, uses a spindle to rotate the wheel within a standard EDM machine where the truing will occur. The wheel can

then be transferred to a grinding machine to perform the grinding operation. Modifications must also be made in the programming of the discharge properties.

1.5.3 ELectrolytic In-process Dressing (ELID) method

FUJI Die Company has developed cast iron bonded diamond wheels [Nakagawa, 1984] that are capable of being electrolytic in-process dressed, ELID. Much of this research has been conducted by the Materials Fabrication Laboratory in Japan by Dr. Hitoshi Ohmori [Qian et. al, 2000]. This research claims, “Dressing by electrical discharge is a good method, but it is difficult to conduct on-line dressing.” As implied by the name ELID is only a dressing method, EDM was first used to true the wheel, then ELID is used to continuously dress the wheel during grinding operations.

Ohmori claims that ELID has so far served as the most successful dressing method for metal bond wheels in precision surface grinding [Ohmori, 1996]. Although this method does create good surface finish, the ability to dress precise forms has not been shown. All of the papers reviewed, including Zhang’s internal grinding [Zhang, 2000], incorporate ELID for dressing a straight profiled wheel. It is important to recall that this process is unable to true the metal bond wheel. ELID is used only as a dressing process; EDM is still required to true the wheel. If ELID proves to be capable of dressing precise formed metal bond diamond wheels, precise EDM truing will still be required to form the wheel.

1.6 Patent Search

Patentability of the WEDT process is a possibility, due to its uniqueness of using a standard wire EDM machine. All of the Japanese patents by Mizukawa et al. [1992], Shichizawa [1993], Oku et al. [1984], and Nakagawa et al. [1989] deal with EDM truing using a die sinking rotary electrode. No patents could be found which use a standard wire EDM machine, to perform the truing operations. It is important to note that this process is valuable for its flexibility within the machine shop; it is not intended for production grinding. In this case the EDM truing unit would be integrated with the grinding machine to eliminate removal of the grinding wheel for truing. It also becomes valuable in an experimental environment for creating prototypes for testing purposes. The only equipment required to perform the truing is a precise spindle and use of a traditional EDM machine.

2 SPINDLE DESIGN

One of the initial challenges in the research was to design a spindle that would rotate the wheel inside the EDM machine. When the research was first underway, it was desired to purchase an industrial “off the shelf” spindle which could be modified in order to mount the wheel. Spindle’s offered by System 3R were considered, but the amount of modification required in order to mount the wheel to the spindle was substantial. Another drawback was high price. Thus, the first step was to design and build a spindle that could meet the defined requirements.

Corrosive Environment – This spindle would have to operate in the presence of deionized water. Therefore, all components that will be in direct contact with the water will require corrosive resistant materials. While those components that cannot perform in the presence of water, like the motor, will have to be shielded in the design.

Electrical Environment – The metal bond wheel must be electrically grounded to the machine for the EDM sparking to occur. Thus, the spindle must be able to carry high electrical current to ground. Also any gaps within this path could become a potential location where electrical spark could occur.

Tight Tolerances – In order to obtain the μm tolerances desired in the profile on the wheel, the spindle must also be up to this standard. Goals of robustness and high precision were at the forefront during the design and manufacturing of the spindle. Also spindle vibrations must be minimized to achieve this μm tolerance.

Geometry Restraints and Flexibility – The most obvious requirement in geometry is a method for mounting the wheel on the spindle in a repeatable manner. Also the wheel

must be able to be placed on a grinding machine in the same fashion. The design should also be able to except varies grinding wheel diameters. A compact spindle must be accomplished to avoid interference with the EDM machine.

2.1 Overview of Spindle Design

The spindle consists of a speed controlled gear motor, cooling fan, belt and pulley system, shaft, a four piece housing, two brush assemblies, and two bearings, as shown in Figure 2.1. The grinding wheel is mounted to a hub, which has a precision ground internal taper to allow mounting on a grinding machine spindle. Therefore, this same taper is used on the spindle shaft to except the hub. This will assure repeatable mounting, as well as easy wheel transferal to the grinding machine. Two brush assemblies provide a path to transfer the EDM current from the shaft to the grounded housing. A speed controlled, fan cooled, gear motor is used to provide rotation. In order to reduce

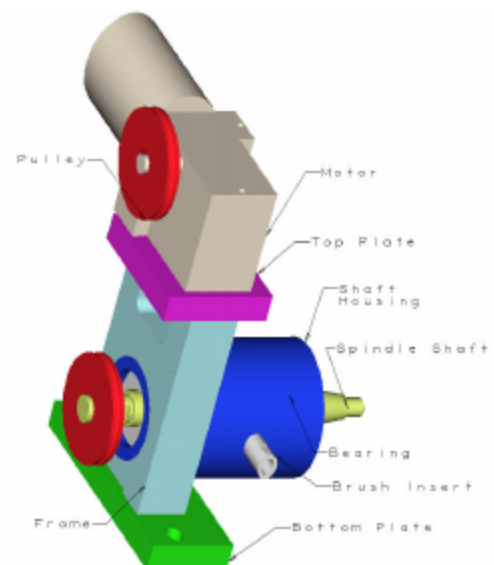
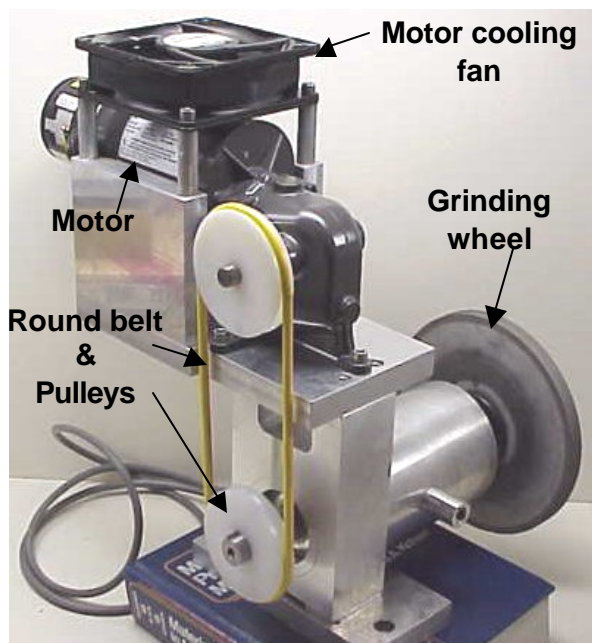


Figure 2.1: Final Spindle Configuration

vibrations in rotational transmission, a smooth round belt and pulley system was implemented.

Two deep-groove ball bearings with silicon nitride balls and stainless steel races were used to support the shaft. These bearings provide corrosive resistance to the deionized water, while isolating the bearings from the current flow. All other spindle components are made of water corrosion resistant materials, such as stainless steel, plastic, or aluminum. The finished spindle met the precision requirements by achieving a runout of less than 1 μm .

2.2 Spindle Components

In order to create the spindle some components were purchased from a supplier, while others were machined at Cummins Technical Center. The following two sections discuss the reasoning behind the component selection.

2.2.1 Purchased Components

To rotate the spindle a DC permanent magnet motor was chosen, due to low cost and excellent speed control. Also since gear motors allow rotation to be transferred along an axis other than the motor axis, clearance between the motor and EDM head was easy to maintain. Dayton also supplies a direct mount speed controller for the gearmotor, which allows speed control from 0 to 89rpm in twenty increments.

Several types of belts were considered for this application. A timing belt would provide a no-slip condition but the power transmission is somewhat “incremental” due to the mating of the teeth. A V-belt would have been effective but could create potential

trouble in installation and would require a belt tensioner to adjust the belt. To eliminate this extra component and to simplify the assembly, a polyethylene round belt was used. The belt is stretchable which makes installation easy and no tensioner is required. Also the belt can be cut to length and joined together with aluminum connectors.

The bearing selection was the key to the success of the spindle. They had to be rigid (preloaded) and also withstand the corrosive environment. Both plastic and stainless steel bearings were considered. Steel would provide a rigid support, which is needed to obtain the tight tolerances. However, with steel bearings the concern was about the balls causing spark erosion on the races. Current must flow from the wheel, through the shaft and bearings into the grounded housing. If the balls are not preloaded firmly against the races then the current will jump the gap and begin to erode the balls and pit the races. Also the surface area of contact is very small thus creating a resistance to current flow, which is not good for the EDM process.

A solution is to prevent current from flowing through the bearings, by making the balls insulators instead of a conductors, thus ceramic bearings were incorporated. To ensure that the deionized water could not get into the sealed bearings, additional oil seals were used to seal the bearings from the environment. A snap ring, Figure 2.2(a), was used to assure bearing/shaft alignment and also to prevent axial motion of the shaft.

As previously mentioned there must be a conductive path between the wheel and ground. Since the ball bearings are non-conductive, a brush assembly was used to carry the current from the shaft to the housing. A shunt on the brushes was used, since the small diameter loading spring would not be able to handle the heavy current flow created

by EDM. The brush geometry was rectangular to keep it from cantering in the slot as it rubs against the shaft. This required some wire EDM machining to create the square rectangle to receive the brush. Also an additional insert was added to allow adjustment of brush force on the shaft, as shown in Figure 2.2(b).

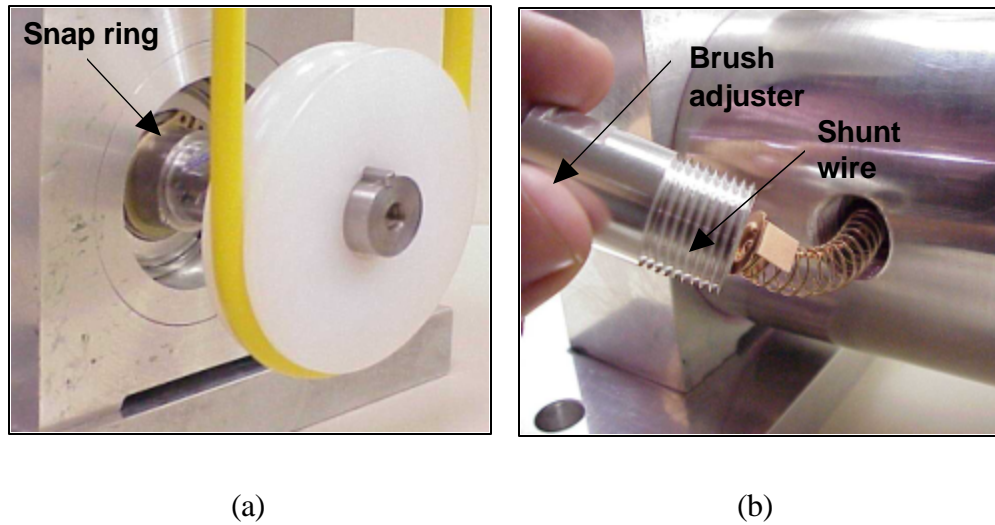


Figure 2.2: (a) Snap-ring location (b) Brush adjuster and shunt wire

One concern in the design was how to ensure that repeatable positioning of the grinding wheel between the EDM and grinding machines. This is due to the fact that profiling would have to be done in an EDM machine, but then moved to a grinding machine to perform any machining test. Grinding wheels are typically mounted using a tapered hub, which assures repeatable mounting. This same tapered hub mount was used to position the wheel on the spindle shaft. Table 2.1 gives a summary of all the purchased components, the supplier, part number, and a brief summary of the specifications.

Table 2.1: Purchased components used in constructing spindle

Component	Supplier	Part #	Specifications
Dayton DC permanent magnet right angle motor	Grainger	6A191	89rpm; 34 in-lb torque 1/10 hp
Dayton gearmotor speed controller	Grainger	4Z728	Input 115AC Output 90VDC
UHMW Polyethylene pulley	McMaster Carr	6284K51 6284K52	2" and 1.5" OD pulley 1/4" round belt groove
Polyurethane belt	McMaster Carr	6567K52	1/4" round belt, cut to size and join with fasteners
Ceramic ball bearings with stainless steel races	Barden Precision Bearings	C205FF5 G-6	C-205 geometry Silicon nitride balls Stainless steel races
Oil Seal	Chicago Rawhide	9763	C-205 geometry (52mmX25mm)7mm deep
Carbon brushes with spring and electrical shunt	McMaster Carr	65705K38	5/16"X15/32" 7/8" long
Grinding wheel hub mount	MSC	28905923024	Ground taper Mounts to 2 1/4" ID wheel

2.2.2 Manufactured Components

The main manufactured component of the spindle is the shaft, Figure 2.3, which transfers the rotation of the belt on one end to the grinding wheel on the other end. The

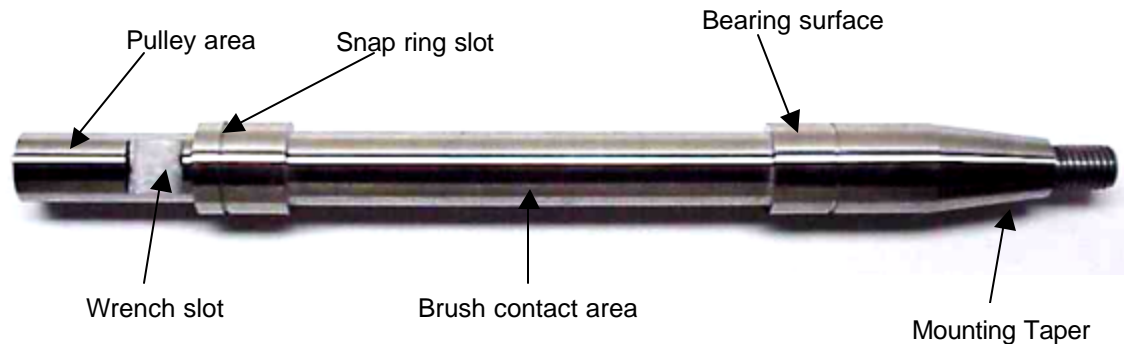


Figure 2.3: Features of spindle's shaft

left end of the shaft features a pulley area with a keyhole slot to insure no slippage between the pulley and shaft. A wrench slot was added to hold the shaft during installation and removal of the wheel. Both ends have a bearing surface, which will accept the ID of the bearing, and also a snap ring slot as mentioned earlier. The right end has the taper to accept the hub as well as the threads that will secure the wheel to the shaft. Since the carbon brushes contact the middle of the shaft, stainless steel was the material of choice, unlike the other components, which are aluminum. The shaft was ground to the specifications to ensure good surface finish for the brush contact and press fit areas.

In order to combine and support the components, a frame assembly was machined at the Experimental Machining Lab at Cummins Technology Center. A bottom plate serves as the base and will be mounted to the table inside the EDM machine. Figure 2.4 shows how the motor is mounted to a top plate. A frame was designed which would join the bottom and top plates and also accept the shaft housing, as shown in Figure 2.4.

Initially the housing was going to be bolted to the frame. The problem is that the two bearings would be mounted into separate components, both the shaft housing and frame, creating alignment issues. Extending the housing and press fitting it into the frame eliminated this problem. Now the shaft and bearings are both in line with the same bore. The housing was designed to also accept the bearings, seals, and brushes.

2.3 Assembly and Spindle Error

In order to achieve a sub- μm spindle error, as this spindle does, certain steps must be followed during assembly. To allow flexibility for alterations to the spindle height for different EDM machines the top plate, bottom plate, and frame were all bolted together. Figure 2.4 shows that a press fit was used to connect the frame and shaft housing, since it is important that these components are never uncoupled. Some concern rose that the bearing bore in the shaft housing may shrink when the shaft housing and frame were

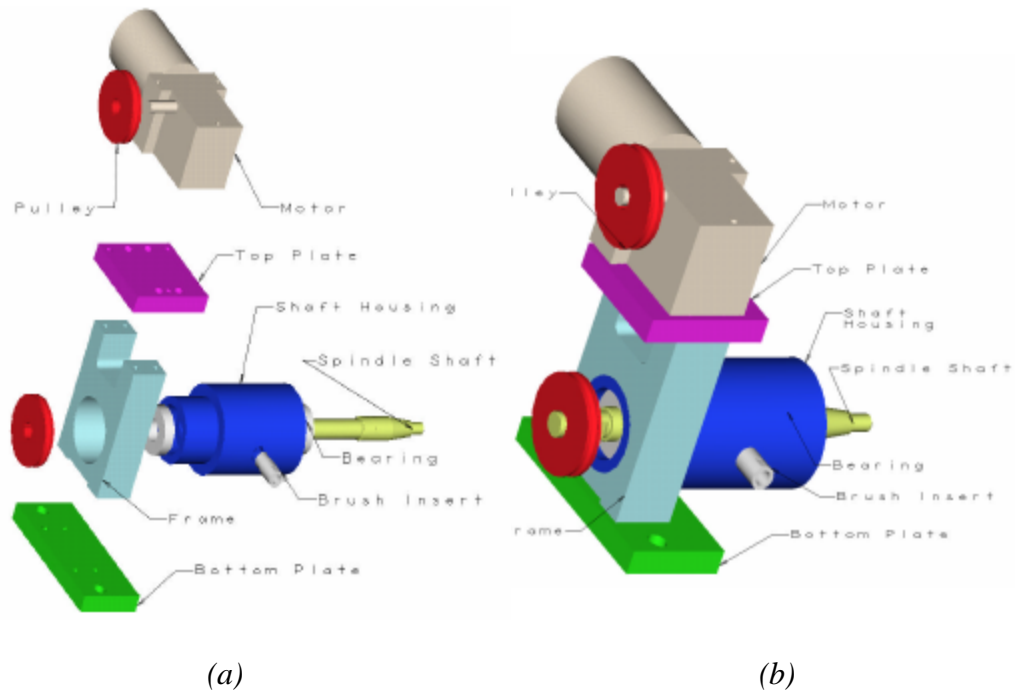


Figure 2.4: (a) Exploded view of components (b) Assembled components

pressed together. Thus after the four parts were joined the final boring of the holes to accept the bearings was completed.

The bearings, which are a 0.0005" interference fit between both the housing and shaft, created a little challenge. This was due to the fact of the number of surfaces that

must mate at the same time. First the frame was heated to 450°F in an oven to get the required thermal expansion. Meanwhile, the shaft was submerged in liquid nitrogen for about 10 minutes to get the required thermal shrinkage. Then the bearings, shaft, and housing were pressed together and allowed to stabilize back to room temperature overnight to create the press fit.

Spindle error was measured using a shaded pole inductor measuring device. The flat surface, where the bearings are mounted, was measured which gave a spindle error of about 2 to 3 μm peak-to-valley. When the error was measured on the ground tapered surface, spindle runout was 38 to 40 μm peak-to-valley. The wheel hub taper was ground on a different setup than was the shaft and bearing surfaces. Therefore, the taper's axis of rotation and that of rest of the shaft are different. To compensate for this error, the final taper on the shaft was performed with the shaft mounted in the bearings and housing.

Figure 2.5(a) shows the setup for grinding the precision taper. A sine table was used to get the taper angle and the spindle's motor was used to rotate the shaft. By moving the grinder head along the axis of the spindle and taking light depths of cut, the taper was ground into the shaft. A machinist dye was used to blue the surface of the taper to insure a good fit between the shaft and hub taper. This task was time consuming, but it paid off with a spindle error less than 1 μm , around 0.6 μm . By insuring that the taper's axis is concentric to the axis of rotation, repeatable mounting between the spindle and grinding machine is feasible.

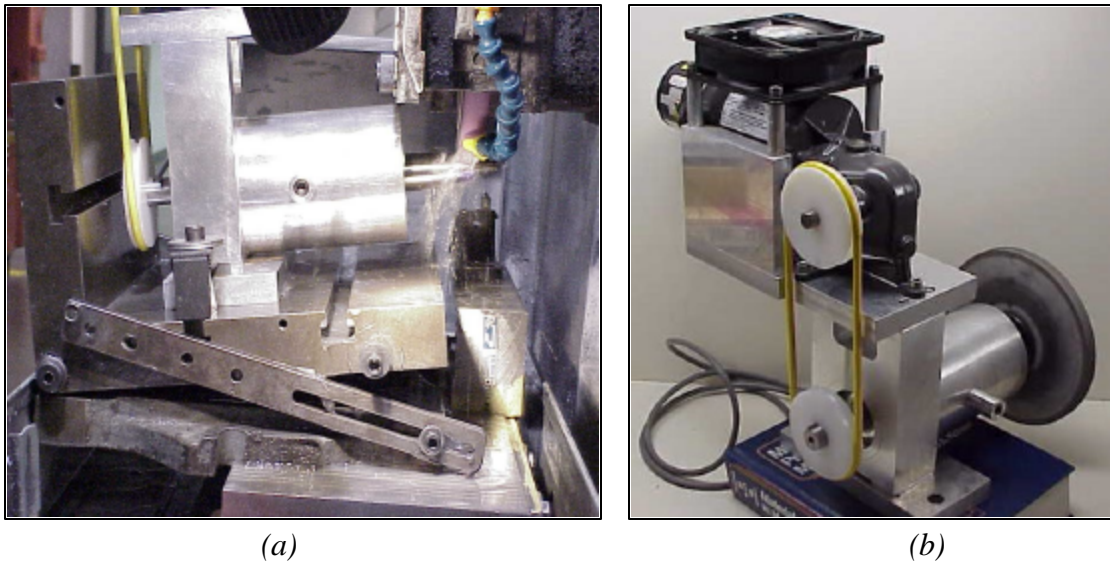


Figure 2.5: (a) setup for grinding hub mount taper (b) completed spindle

Also the motor on the spindle got warm after continuous usage. The motor sets inside the EDM machine where the air is stagnant, thus the problem could be resolved by installing a small computer cooling fan, Figure 2.5(b), to create air flow over the body of the motor.

Once the brushes were installed resistance between the shaft and housing was checked with a multi-meter to ensure adequate shaft/brush contact. The resistance was only about 2Ω , which creates an ideal situation of low resistance to current flow for EDM. While using the spindle it was noted that an oxide layer did form between the brushes and the surface of the shaft. A thin coat of electrically conductive grease between the two surfaces solved this problem.

3 SETUP FOR WIRE ELECTRICAL DISCHARGE TRUING AND PROFILE CAPABILITIES

When performing WEDT certain procedures must be followed in order to insure a properly trued wheel. Since WEDT is not a traditional process, an adjustment of the EDM parameters is required. Chapter 3 discusses these modifications and setup procedures. In order to determine some of the profile capabilities two grinding wheel forms were adopted. An arc profile, Figure 3.1(a), was used to measure form error, via a Talysurf measurement. While a peak profile, Figure 3.1(b), helped to determine minimum inner and outer profile radii achievable on the ground parts.

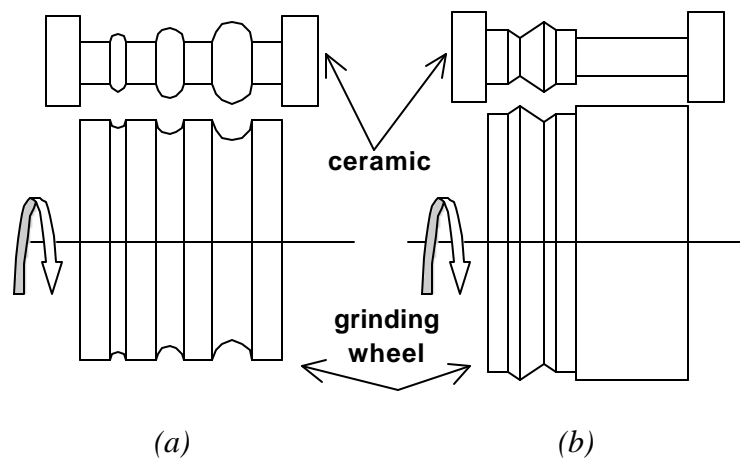


Figure 3.1: Profiles used for determining WEDT capability
 (a) arc profile used for determining form error
 (b) peak profile used for determining minimum form radii

3.1 Performing WEDT

One advantage of WEDT is that it is performed using a traditional wire EDM machine. This makes the process desirable, due to the fact that no new machinery is required. However, since the WEDT is not a traditional EDM procedure, additional knowledge is required to perform the process. The following two sections discuss the WEDT setup procedures, as well as the EDM process parameters.

3.1.1 Setup Procedures

First the wheel/hub assembly is bolted to the spindle shaft. Then the complete spindle/wheel assembly is bolted to the worktable inside the EDM machine, which serves as the electrical ground. A dial indicator is then used to insure that the spindle and machine's axes are aligned. In order to determine orientation of the workpiece relative to wire, an edge find command was executed. The wire moves in slowly until it detects the electrical ground of the wheel. By doing this in both directions, the exact location of an edge of the wheel can be defined. The wire is then backed away from the edge about 2.54 mm in order to allow sufficient space for the machine to automatically rethread the wire in the event of a wire break. This is the start point from which machining will begin.

Normally, the workpiece in EDM machining would be submerged in a dielectric bath for improved flushing and temperature control. However, if this process is determined feasible and the technology was integrated in a grinding machine, it would be impossible to submerge a grinding wheel on a grinder. Thus it is better to develop the technology using only a jet or mist of water to provide the dielectric fluid. Flushing was

not an issue, since the wire is only working on the surface, and is not buried within the material. Jet flushing can be seen during WEDT in Figure 3.2. A mist of high-pressure water could also provide adequate flushing, however this was not investigated in this study.

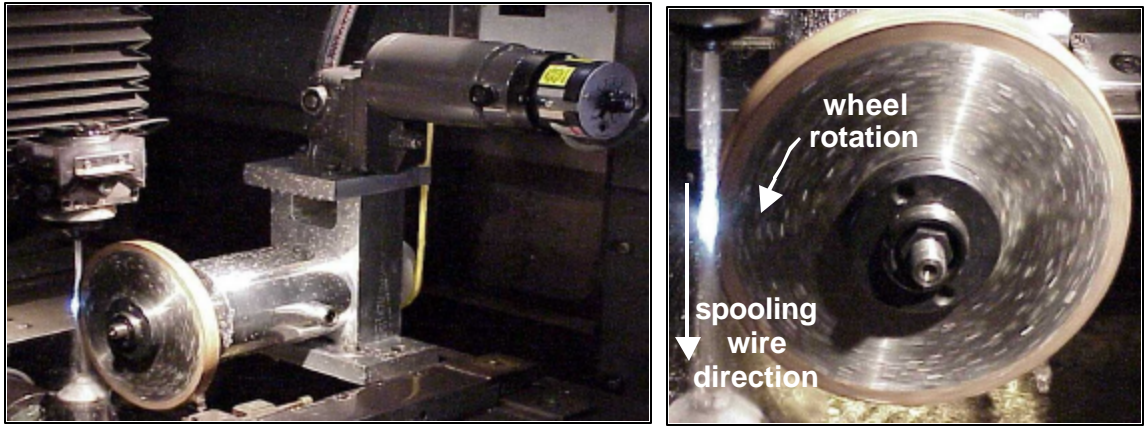


Figure 3.2: Spindle/Machine Setup for MBD Wheel Profiling

Rotation of the wheel was set to make the surface velocity of the wheel match that of the spooling wire, as seen in Figure 3.2. The relative velocity between the two surfaces is minimized. Wheel rotation in the opposite was also tested, which lead to frequent wire breaks.

3.1.2 Process Parameters for WEDT

Since WEDT of a metal bond diamond wheel is not a traditional EDM process, predetermined EDM parameters are not established. Through an understanding of how the parameters interact and trial and error the parameters are adjusted to perform EDM

truing. Due to the fact that the metal matrix of the grinding wheel is about 80% copper, a predetermined program for ¼" copper was selected to be modified. There are six major EDM parameters that are important and are summarized in Table 3.1. A brief discussion on why four of these parameters are altered from the base program follows.

Table 3.1: Summary of EDM Process Parameter Alterations for WEDT

EDM Process Parameters	Baseline ¼" copper settings	WEDT settings
Gap Voltage (V)	35	70
Spark Cycle (µs)	19	32
On time (µs)	12	12
Feedrate (mm/min)	6.6	0.254
Wire Speed (mm/sec)	12	25
Wire Tension (grams)	1800	1800

The gap voltage is the nominal voltage in the gap between the wire and workpiece. Thus the further apart the wire and workpiece are the higher the gap voltage, and vice versa. By increasing the gap voltage from 35 to 70 V, the distance between the wire and wheel is increased. Since the workpiece is circular and the wire is straight, the gap distance varies across the work zone, as shown in Figure 3.3.

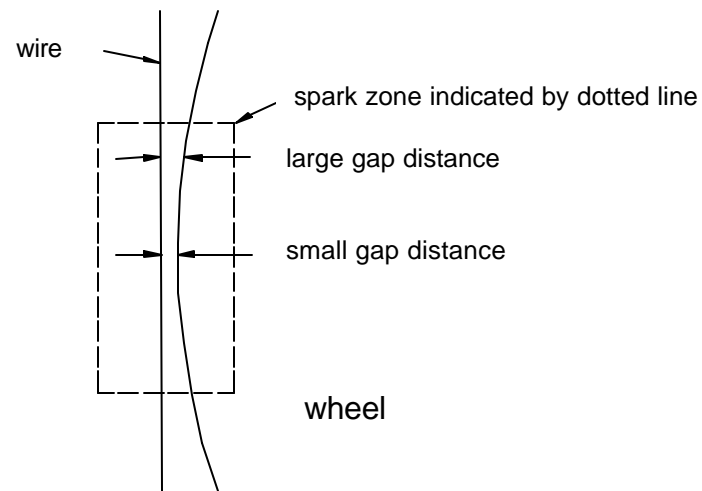


Figure 3.3: Diagram of WEDT gap

Remember that gap voltage is an average of the voltage over the work zone. If a low gap voltage were selected the wire would try to maintain that voltage as an average. Due to the large gap distance toward the outer edges of the work zone, the wire would have to become closer to workpiece to maintain the low gap voltage. This makes the gap at the center of the work zone very small. This small distance causes flushing conditions in which the melted metal does not have the proper room to escape the gap. Under these conditions, a short between the wire and workpiece occurs and the wire breaks. Through an understanding of this phenomenon, a large average gap voltage was used to avoid the associated problems.

As shown in Figure 3.4, the spark cycle is the period of the spark, including both on and off time. EDM uses a DC power supply and capacitor like energy storage bank to create the discharge. During the off-time the capacitors are charged up, then the circuit is completed and the energy is discharged during the on-time. This total time for charging and discharging is the spark cycle. The spark cycle is increased from 19 to 32 μsec . This is done to keep the wire from eroding to the point of burning itself into. In WEDT material is continually feed into the gap not only by the feedrate, but also by the rotation of the wheel. Therefore, the wire is removing more material than in conventional EDM. Thus, by increasing the spark cycle and keep the on-time the same, the off-time is increased, allowing time for the eroded wire to escape from the gap. This also allows more time for the melted material to be flushed out of the gap.

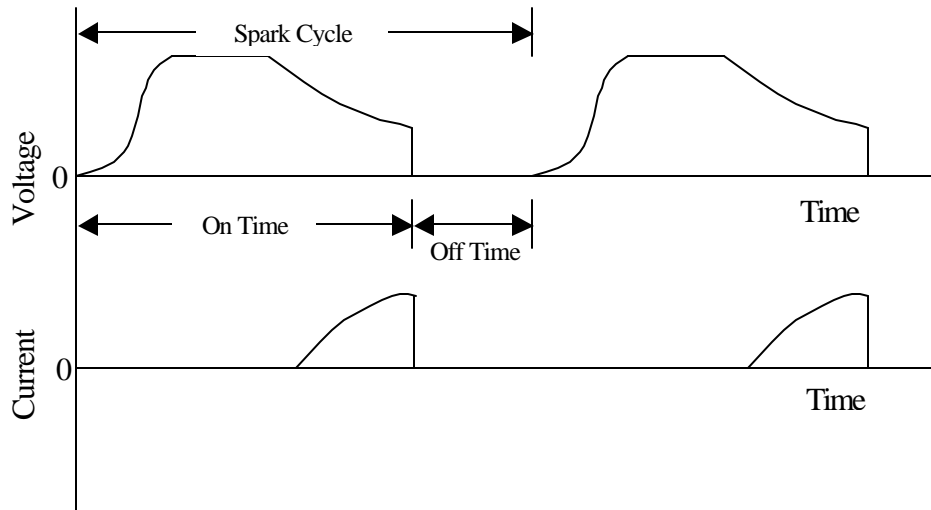


Figure 3.4: Diagram of a spark cycle including both current and voltage

There are two basic velocities of the wire in WEDT. Figure 3.5 shows the difference between these two wire velocities. Feedrate is traverse velocity of the wire as it traces over the periphery of the wheel. For the base program the feedrate is about 6.6

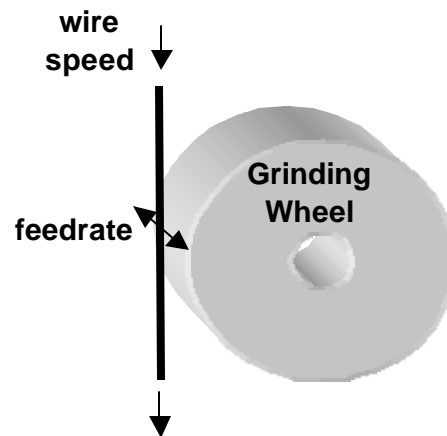


Figure 3.5: Diagram distinguishing between feedrate and wire speed

mm/min, however for the WEDT this is reduced to around 0.254 mm/min. It is important to note that this is not a constant speed, it can be thought of as the maximum speed. The gap voltage is what actually controls the speed at which the wire will travel.

The other wire velocity is the rate at which the wire is being continually spooled into the gap. This is increased from 12 to 25 mm/sec for WEDT. Again this is done to keep the wire fresh and prevent wire breaks. Good erosion would be a decrease in wire diameter from 0.254 mm to a final machining exiting diameter of 0.152 mm. Before the wire speed was increased the exiting wire diameter was around 0.1016 mm, thus many breaks occurred due to the fact that the wire is tensioned to 1800 grams. When the wire speed was increased the existing wire diameter was closer to the 0.152 mm mark and the number of wire breaks decreased.

3.2 Minimum Profile Radii

Another important characteristic to quantify for WEDT is geometric limitations of the process. The ability to create a sharp peak or valley in the wheel is one such characteristic. In order to establish a value for this parameter, a peak-valley profile was implemented, as shown in Figure 3.6. This will enable the determination of both protruding and recessed geometry in the wheel.

The profile created will be initially ground into machinable plastic first to insure no wear of the wheel. This will allow the true form of the wheel to be determined. A Rank Taylor-Hobson Talysurf was then used to trace the ground component's profile, to determine form error. It is important to note that these values are for a 320 grit Sceptor wheel at a specified machining condition. If a finer grit wheel were used the form error could feasible be better than that of the 320 grit wheel tested.

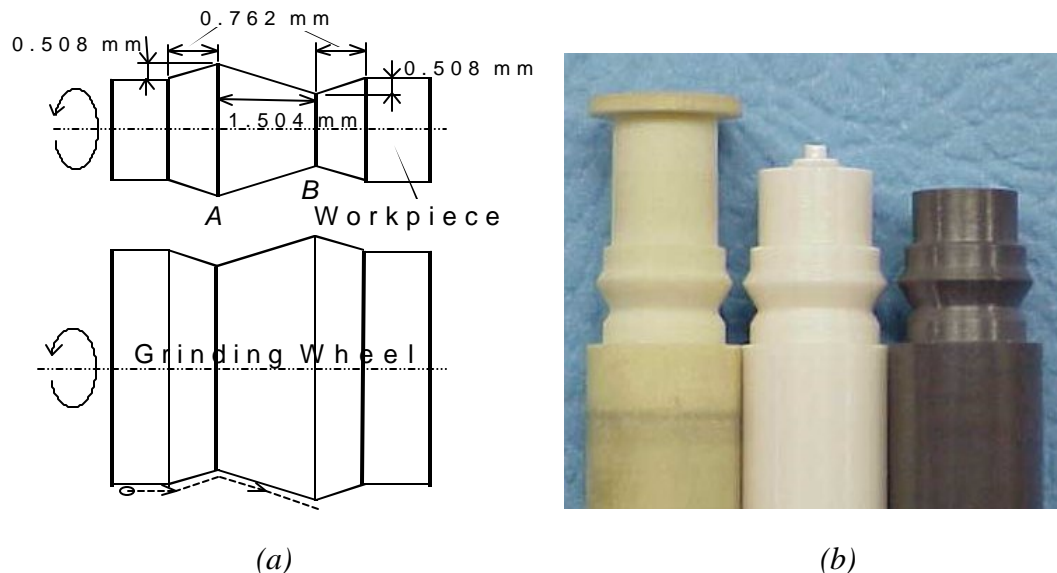


Figure 3.6: Peak-Valley profile (a) dimensions of peak profile and wire EDM path
(b) plastic, zirconia, and silicon nitride ground pieces

After the plastic was ground some zirconia and silicon nitride parts was also ground to provide some “show-and-tell” pieces, refer to Figure 3.6(b). Since the EDM machine was programmed for a no radius corner, the radius created during machining was considered the resulting minimum radii that can be achieved for this particular diamond abrasive grain size. The minimum radius for a peak part geometry, shown in Figure 3.6(a) as area A, is 108 μm . While for a valley part geometry, shown in Figure 3.6(a) as area B, the minimum radius was about 82 μm .

These measurements were again taken on a Talysurf machine with a 60° - 2 μm radius tip stylus. One EDM parameter that could decrease the minimum radii would be to increase the wire tension, which was extremely low for this profile. Turning off corner control, which allows the traverse speed to decrease in turns and corners, could also improve the minimum radii. This is due to the fact that overburn at the corners could be allowing unwanted material removal at the tip of the profile. However, most ceramic components do not require corner radii less than the ones achieved, due to stress concentrations that are created at sharp corners.

3.3 Form Error

The goal of the project is to have to capability of precisely profiling a metal bond diamond grinding wheel. In order to have a precise profile, the form error of the profile must be minimized. This particular setup resulted in a form error of about $2.4\mu\text{m}$. Form error encompasses the long wavelength deviations of a surface from the corresponding nominal surface. Form errors result from large scale problems in the manufacturing process such as errors in machine tool ways, guides, or spindles, insecure clamping, inaccurate alignment of a workpiece, scale resolution of axis, or uneven wear in machining equipment. Form error is on the dividing line in size scale between geometric errors and finish errors. [Precision Devices, 2001]

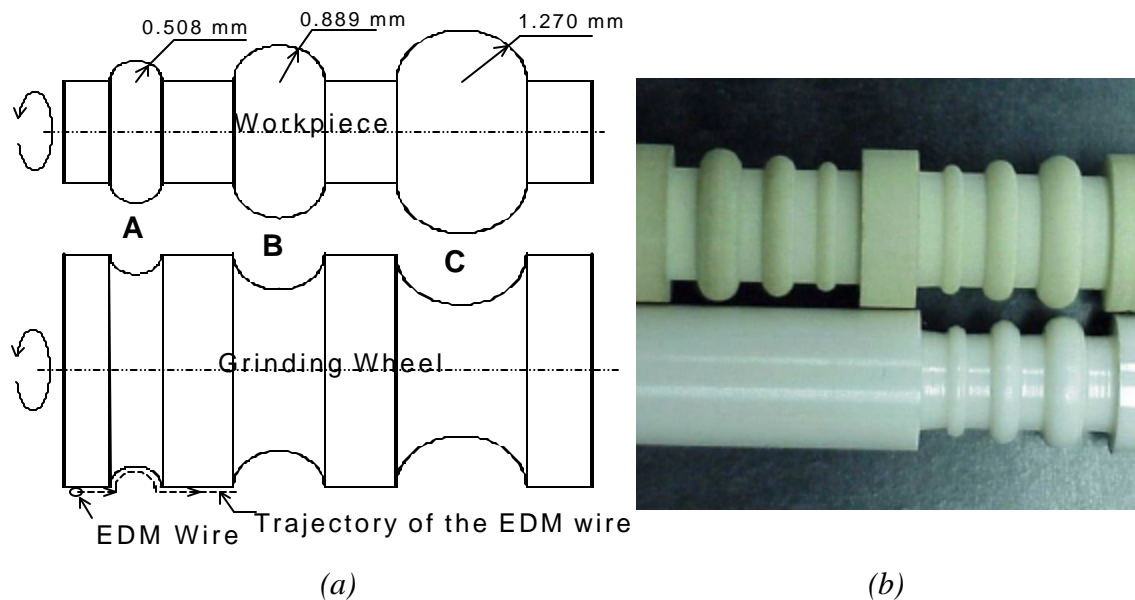


Figure 3.7: Arc profile (a) dimensions of arc profile and wire EDM path
(b) ground plastic and zirconia parts

Figure 3.7 shows the arc profile that was used to determine form error capabilities of the EDM truing process. With this profile the machine will have to make steps in both the x and y directions. An arc is the standard shaped used in the determination of form error. Note that this is dependent on the EDM's machine quality and the performance of the spindle along with other factors. Thus if any of these parameters are changed, these tolerances will not be the same. The forming of the wheel was performed in a single pass that removed the bulk of the material. An additional cleanup pass, using the same machine path, was required to ensure complete spark out.

After the profile was burned into the wheel, the first pieces were machined. A Centerless Deadtrue grinder at Cummins Technical Center (CTC) was used to grind a piece of machinable plastic. The plastic allows machining with no wheel wear, thus revealing the true form of the wheel. Then by using a Taylor Hobson Form Talysurf with 1 mm ball stylus, the form error was determined.

As mentioned previously form error is a dividing line between finish and geometric errors, i.e. difference between surface roughness and surface waviness. The software that analyzes form error data from the Talysurf first has to establish a base from which to measure error. By using the circle fit feature in the software an average radius "perfect circle" is created on which to compare the data. Form error is then defined as the peak-to-valley deviation from this circle, which has the mean radius of all data points taken.

The arc was measured and analyzed with both a .08mm and .25mm cutoff, to give a form error of 6.5 μm and 2.4 μm , respectively. The cutoff is defined as the threshold of

wavelength for which will be keep for analyze, all waves with wavelengths shorter than that are removed from the data. The smaller the cutoff wavelength then the more surface roughness will skew the form error results. But, if to large a cutoff is used some of the form error may be lost. There is a fine line in determining this cutoff length; the standard in metrology is 0.25mm. Figure 3.8 shows the results from the form Talysurf software. One additional note is that the mean arc radius is removed from the data, thus the deviation is measured from the x-axis on the graph. Also note that this is a peak-to-valley deviation of the form error. In other words, all the data points can be contained within two concentric circles whose radii differ by the amount of the form error.

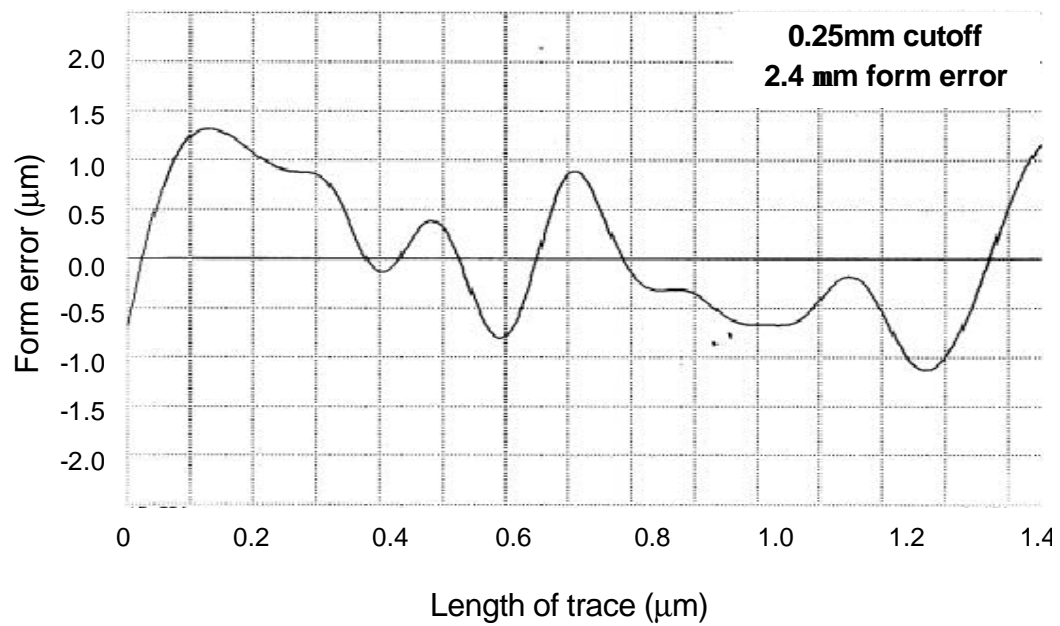
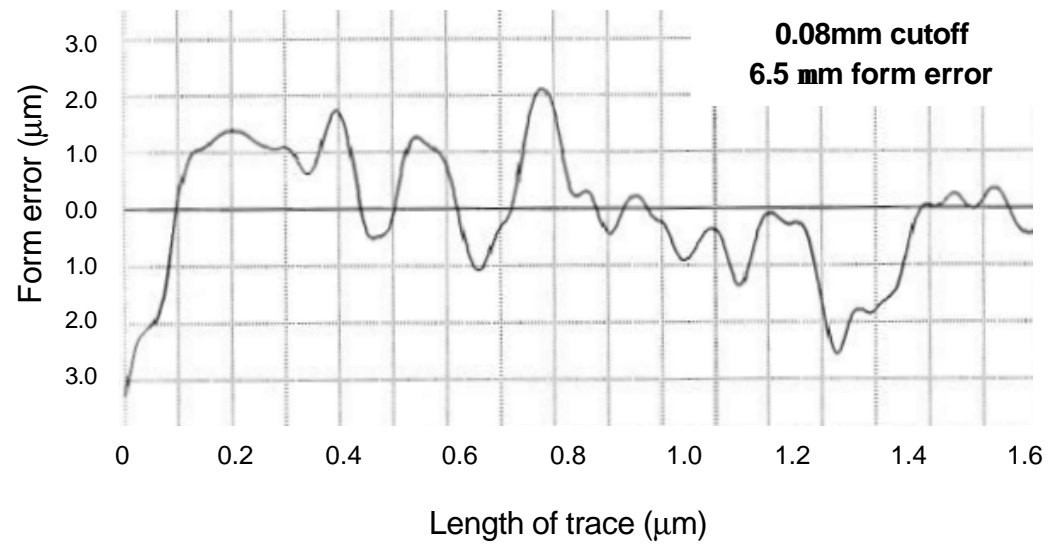


Figure 3.8: Graph of form error with two different cutoff values used to filter the trace data

4 GRINDING STUDY

After WEDT proved feasible to create a precise formed wheel, a study was implemented to examine the wheel's grinding characteristics. The results of a single point diamond wheel were used for comparing the results from the EDM trued wheel. The questions to be answered by the test include:

- Which of the truing methods created a wheel that performed grinding operation most effectively?
- How does surface finish of the ground component compare between truing method?
- How does wheel wear rates compare between the truing methods?

The test consisted of comparing two truing methods for a metal bond diamond grinding wheel. One of the wheels was trued using a single point diamond, while the WEDT process presented in this report trued the other wheel. Because the EDM process performed both truing and dressing simultaneously, the EDM wheels required no additional preparation. The single point trued wheel was dressed with a silicon carbide stick to create chip clearance. The following sections in Chapter 4 will cover the setup of the test and present the results of this study.

4.1 Setup of Grinding Study

As mentioned previously there will be two truing methods compared in this study, thus two truing procedures. The following sections will discuss how the wheels were prepared and also the grinding setup and procedures.

4.1.1 Wheel Preparation

A single point diamond trued wheel was used to compare against the EDM trued wheels. The diamond was feed at 5 $\mu\text{m}/\text{pass}$, and then traversed over the wheel surface at 127 mm/min. The wheel's surface speed during truing was 20 m/s. After the wheel was trued it was then dressed using a 220 grit silicon carbide stick. The stick was fed into the wheel by hand until nearly 25 mm of the stick had been consumed. This will remove some of the metal matrix from around the diamond for chip clearance.

WEDT method presented in this report was used to create a wire trued wheel. With WEDT the truing and dressing was performed simultaneously, thus no stick dressing is required. The WEDT process parameters included a gap voltage of 70 V, spark cycle of 32 μm , on-time of 12 μm , feedrate of 0.254 mm/min, wire speed of 25 mm/sec, and wire tension was 1800 grams

4.1.2 Grinding Procedure

A 320 grit metal bond wheel, Norton's Scepter, was used as the grinding wheel for this study. This wheel has proven, through a study at Oak Ridge National Lab, to provide excellent grinding of a wide range of ceramics. Silicon nitride sample tiles from Toshiba (TSN-10) are used as the workpiece. The samples are 42.5 mm long and have a

width of 6.35 mm. The width of the wheel 12.7 mm, enabling wheel wear data to be collected. The tiles were aligned to the middle of the wheel leaving ungrounded, virgin areas near both edges of the wheel. As the parts are ground a groove will be created into the middle of the wheel due to wear, refer Figure 4.1(a). This groove from the wheel can be transferred to create a step into a plastic wear block, as shown in Figure 4.1(b). This step on the wear block can be measured to determine the progressive wear of the wheel during grinding.

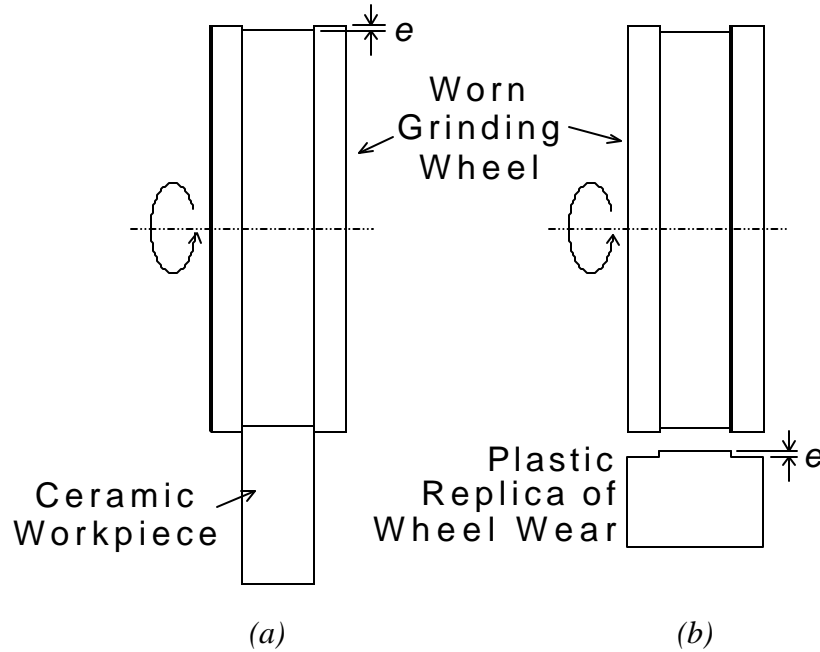


Figure 4.1: (a) creating groove into wheel by grinding silicon nitride (b) transfer groove to plastic wear block

In order to hold the tiles in place during grinding, a fixture was designed and fabricated. As shown in Figure 4.2, this fixture uses a clamping configuration to allow easy and repeatable mounting of the tiles. The fixture is secured to the dynamometer by two bolts. The silicon nitride samples were removed and replaced after each pass. An

ELB CNC controlled creep feed grinder was used to conduct the experiment. This machine has high machine loop-stiffness and a large spindle horsepower, which allows large material removal rates without staling the spindle. A special adapter was designed to allow the small grinding wheel's hub to be mounted to the large arbor.

Figure 4.2 shows the setup of the grinding study. The wear block is mounted in a grinding vise, which is secured along with the dynamometer by the magnetic table. With

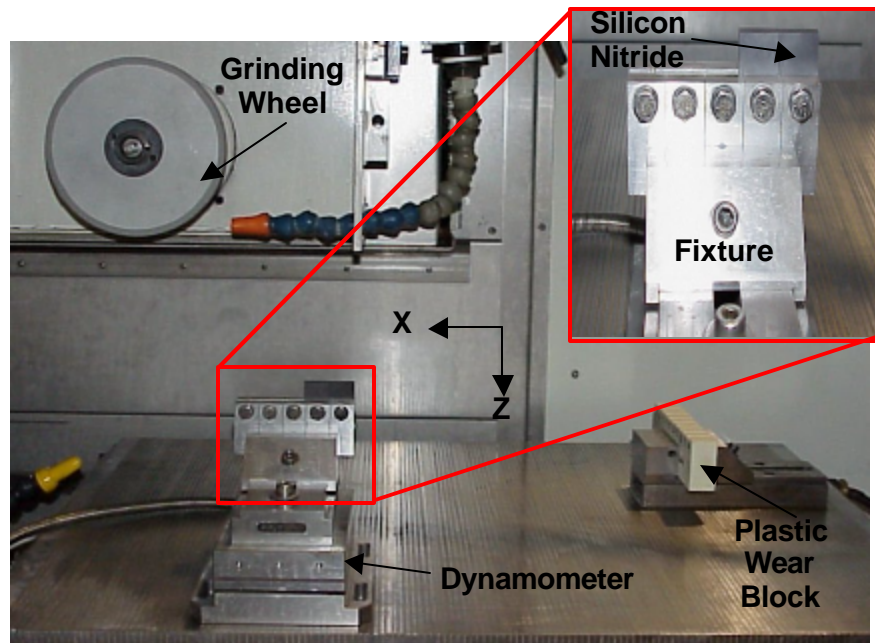


Figure 4.2: Silicon nitride grinding study setup on ELB grinder

the fixtures secured to the table a CNC program is written to perform the repetitive task of the test. This CNC control also insures repeatable positioning of the wheel with respect to the parts after grinding of the plastic wear block. Table 4.1 shows the grinding parameters that were used during the study.

Table 4.1: Grinding Parameters used in Silicon Nitride Grinding Study

Machine	
Type	ELB Perfect Future BD10 CNC Grinder
Spindle Type	Ball Bearing
Spindle power Rating	22.4 kW
Slide	Ball Screw
Coolant	
Type	TRIM 413A
Concentration	5% by volume
Flow Rate	38 liter/min
Filtration	5 μ m paper filter
Grinding Wheel	
Type	Norton Scepter 8inch wheel
Abrasive and Bond	320 grit diamond with metal
Specifications	ME 178393 D-2-MX876D-1/4
Surface Speed	36.6 m/s
Table Speed (feed)	127 mm/min
Specific Material Removal Rate	8 mm ² /sec (DOC 3.81mm)

A six-step procedure was followed during this study:

- 1) Start the data acquisition system to collect force and power data.
- 2) Take one pass over the silicon nitride parts at a 3.81 mm depth of cut
- 3) Stop data acquisition and reposition machine over wear block
- 4) Grind the wear block to transfer groove created in the wheel during grinding
- 5) Replace silicon nitride samples in fixture with new unground samples
- 6) Repeat step 1-5 for at least 10-15 passes of the wheel

By collecting data at every pass, the point at which wheel breakdown occurred was identified. The point where the force and power data began to develop peaks, instead of

smooth transitioning line, was defined as the breakdown point. Also by replacing the samples after every pass with new ones, a graph of surface finish as a function of material removed was constructed. In the following sections, these grinding trends are discussed and some theory is developed to describe the trends.

4.2 Grinding Forces

The load on the spindle was measured during grinding in order to determine the most effective truing method. If the wheel is “open”, the spindle load will be low. If the wheel is not open, i.e. no chip clearance, then the diamonds are not exposed properly and spindle load will be high. The next two sections discuss the instrumentation used to gather the data and the results from the study.

4.2.1 Instrumentation to Collect Force and Power Data

In order to measure this spindle power, a Hall-effect power sensor was installed on the ELB machine. Since power is the product of voltage and current, the load monitor measures the current and voltage from the three-phase spindle power supply. Then a DC voltage output signal is given relative to the spindle load, which is then converted to power by a calibration constant. The output signal was passed through a low-pass RC filter to remove unwanted noise from the signal. The cutoff frequency is determined by equation 4.1, where R is the resistance and C is the capacitance.

$$f_{\text{cutoff}} = \frac{1}{2 \delta \cdot R \cdot C} \quad (4.1)$$

With R set at 36Ω and C selected at $10\mu\text{F}$ the cutoff frequency, f_{cutoff} , is 442 Hz. This value is well above the 60 Hz of grinding frequency.

Grinding forces were captured in the vertical and horizontal directions using a KISTLER 9257B 3-axis force dynamometer. Two KISTLER 5010A charge amplifiers were used to boost the signal, as shown in Figure 4.3. The sensitivity for the X- and Z- directions, as defined previously in Figure 4.2, were set to 7.5 and 3.5 mv/MU, which are the specifications of the dynamometer, and the scale factors were 100 and 200 MU/volt, respectively. A portable PC with a National Instrument Data Acquisition Card (DAQ) was used to collect and store both the force and power data. LABVIEW, a graphical programming software package, was used to route the data from the DAQ card into a text file. This file could be imported into a spreadsheet for data manipulation.



Figure 4.3: Force and Power Data Acquisition System

4.2.2 Force Results

In grinding, forces are generated due to friction between the wheel and workpiece. This is required in order for the abrasive grains to remove the work material. However, for a given depth of cut and grinding conditions, these forces should be minimized to reduce wheel wear. One factor that affects the magnitude of the grinding force is how well the wheel has been dressed.

Dressing refers to the removal of the metal matrix that surrounds the diamond abrasive. If done properly the diamond should be protruding from the metal matrix surface, creating chip clearance. Thus, as the abrasive grain plows through the workpiece, the removed material has an area to be accepted. Then, as that area rotates out of the grinding zone the chips are discharged from the wheel. If the space around the abrasive is not present, there is no room for the chips to go, which creates high grinding forces. Also if the diamonds are not protruding far enough, then the metal matrix begins to rub the workpiece surface excessively, creating higher frictional forces.

The forces are measured both perpendicular and parallel to the direction of feed. As shown in Figure 4.5, these forces are designated as the vertical (F_v) and horizontal forces (F_h), respectively. Multiple passes are shown in Figure 4.4, at a specific material removal rate of $8 \text{ mm}^2/\text{s}$. The forces increase in magnitude as the number of passes increases, which is expected due to diamond abrasion. Notice that the horizontal forces for both truing methods are similar. Both forces peak at around 100 N for the first pass, and then they follow each other from there on up to six passes over the silicon nitride.

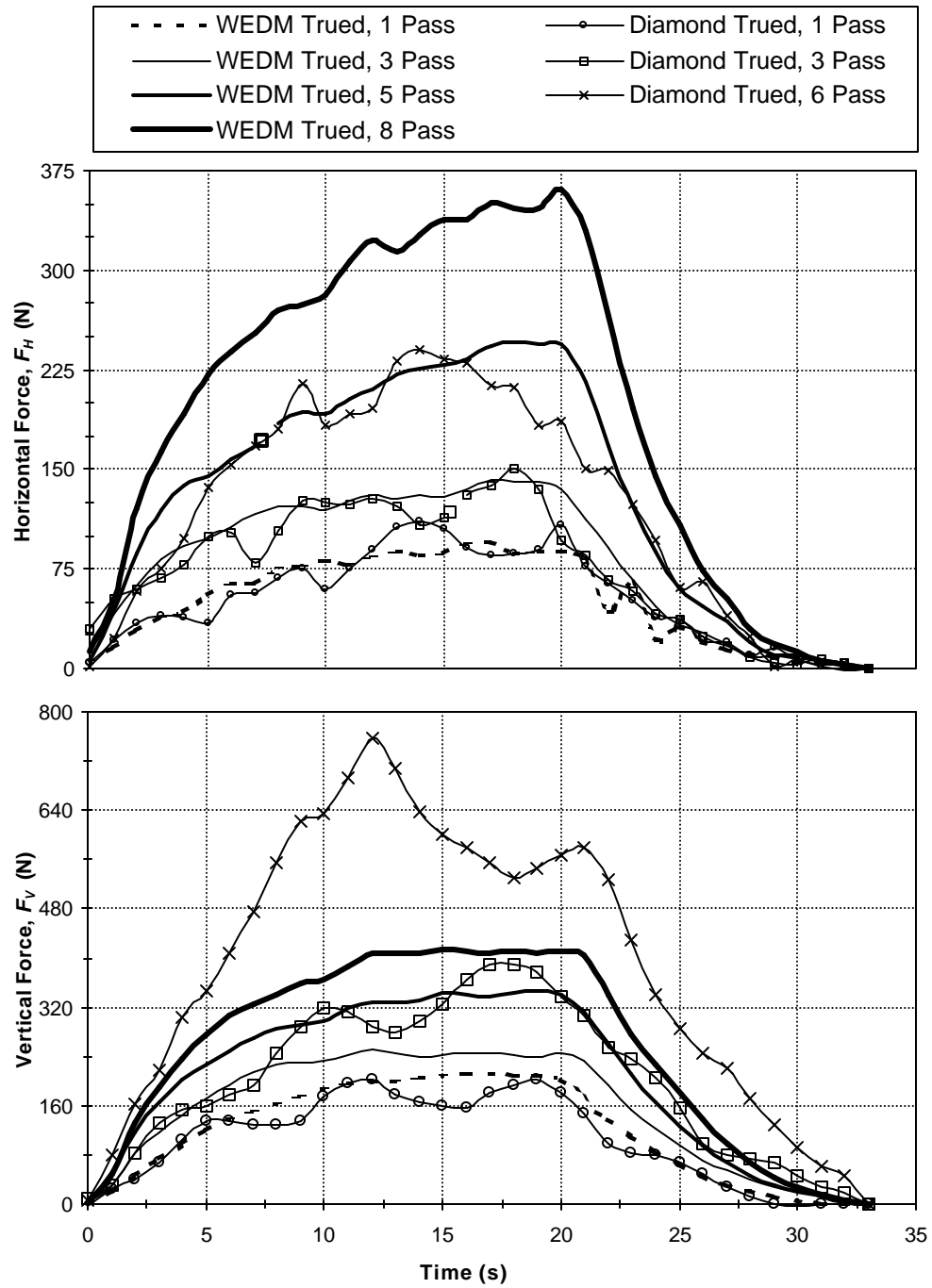


Figure 4.4: Horizontal and Vertical Grinding Forces

However, the vertical forces do not follow the same pattern. Initially on the first pass, both wheels create the same level of forces. The single point diamond trued wheel started to have high force peaks, while the EDM trued wheel had smooth force lines. The force level for the third pass using the traditionally trued wheel was up on the level of the EDM trued wheel after eight passes at around 400 N. The sixth pass with the traditionally dressed wheel reached forces in excess of 700 N. This indicates that the single point diamond trued wheel broke down earlier than the EDM trued wheel.

Under normal surface grinding conditions, i.e. light depths of cut, the force are measured in the vertical and horizontal directions directly are the normal and tangential forces. However, with a creep feed grinding configuration like the one in this experiment, no longer can the horizontal and vertical forces be considered as the normal and tangential forces, due to the large arc of machining. Figure 4.5 shows that the normal and tangential forces begin to slide up the machining arc as the depth of cut (t) increases.

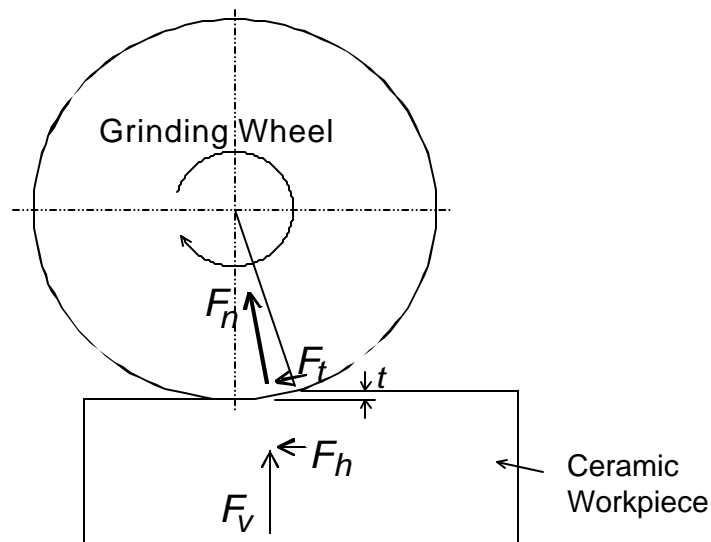


Figure 4.5: Diagram of grinding forces

A conversion must be made to transform the measured values to normal and tangential forces.

Tangential force, as the name implies, is the force that is tangential to the wheel's surface. Torque on the wheel is the product of tangential force and wheel radius. Likewise, spindle power load on the wheel is the product of torque and angular velocity. Therefore by having the power (P_s), horizontal forces (F_h), and vertical forces (F_v) known the tangential (F_t) and normal forces (F_n) can be calculated. Since the resultant force of the vertical and horizontal forces is the same as that of the tangential and normal forces, the relationship can be made that:

$$\left[F_n^2 + F_t^2 \right] = \left[F_h^2 + F_v^2 \right] \quad (4.2)$$

Then, the tangential force is just the spindle load divided by the wheel surface speed (V_s):

$$F_t = \frac{P_s}{V_s} \quad (4.3)$$

By rearranging equations 4.2 and 4.3 the normal force can be found by:

$$F_n = \left[F_v^2 + F_h^2 - F_t^2 \right]^{1/2} \quad (4.4)$$

Figure 4.6 shows the tangential and normal grinding forces that were calculated from the measured forces and power. Again, both EDM dressed wheels are performing

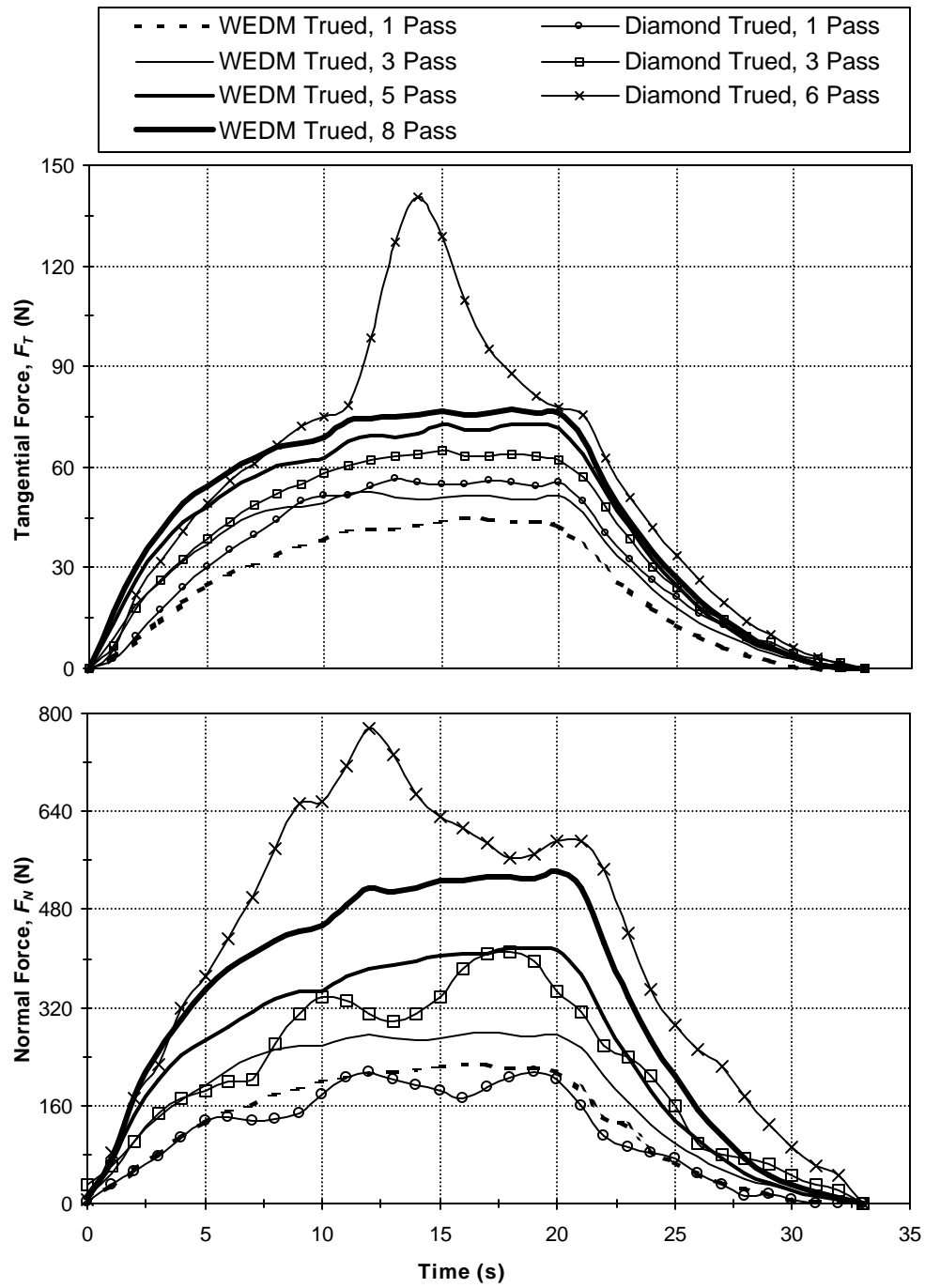


Figure 4.6: Tangential and Normal Grinding Forces

similarly, whereas, the traditionally dressed wheel sees higher tangential forces. Notice that the EDM wheel has tangential forces that are 20% lower than that of the stick dressed wheel. This remains the case until the sixth pass, where the stick dressed wheel begins to break down. The force climbed drastically, which cause the diamonds on the surface to be sheared or pulled out.

Normal forces also shown in Figure 4.6. The forces seen when grinding with the traditionally dressed wheel are 20-40% higher than forces produced when grinding with the EDM trued wheel. On the sixth pass, the normal force reached nearly 800 N for the traditionally dressed wheel. While on the eighth pass, the EDM wheel was only seeing forces around 500 N. SEM investigations were conducted to determine the reason for the force reductions.

Ratios of normal to tangential grinding forces are shown in Figure 4.7. These values are around five for both wheels. It stays nearly constant throughout all passes. Similar values have been reported when grinding zirconia with a silicon carbide grinding wheel. In metal cutting operations this ratio is closer to one. However, in grinding the normal force is usually much greater than that of the tangential force.

In conclusion, the EDM dressed wheel showed a 20-40% lower grinding force than that of a traditionally dressed wheel. With both wheels the force increases as more material has been removed, due to diamond wear. It is important to note that wheel breakdown occurred after 6 passes with the stick dressed wheel, whereas the EDM wheel experienced this after about 15 passes. Thus, the EDM wheel ground nearly three times as long as the stick dressed wheel before breakdown occurred. This increased efficiency

was theorized to be caused by the manner in which the EDM sparks dress the wheel. However, further SEM investigations of the wheels' surface will be used to study this theory.

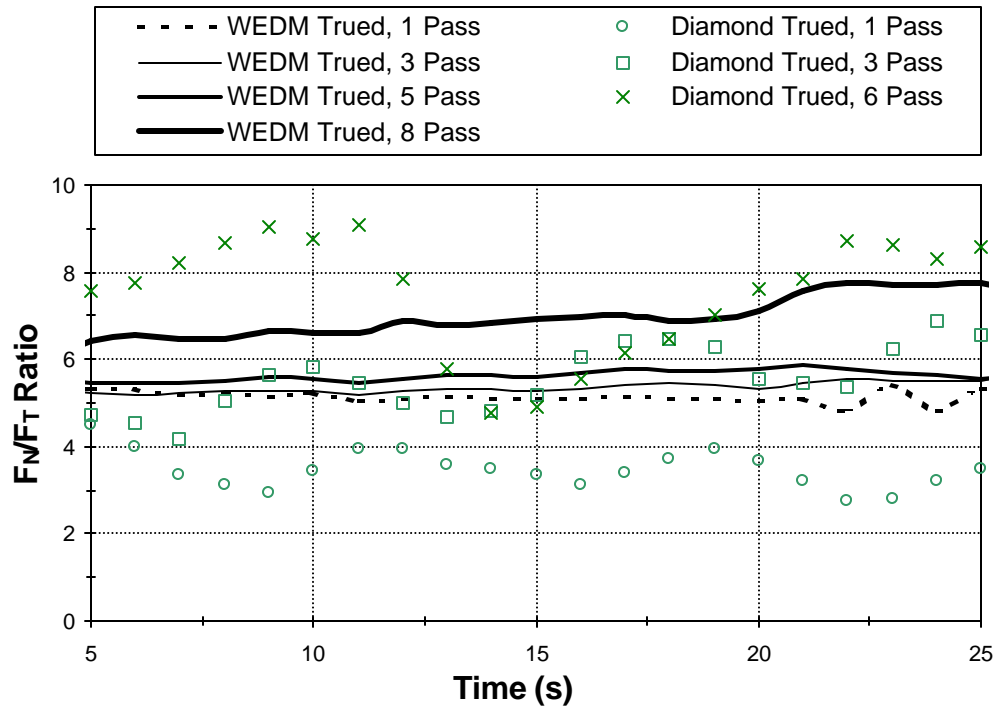


Figure 4.7: Ratio of Tangential to Normal Grinding Forces

4.3 Surface Roughness of Ground Silicon Nitride

Surface roughness is an important factor to ground components. Usually, there is a specified tolerance that must be met in order for the ground component to function properly. The driving factors for surface finish include abrasive size, grinding parameters, and dressing characteristics. For this study, both the abrasive size and grinding parameters were held constant in order to reveal the effects of dressing.

A Talysurf from Rank-Taylor Hobson was used to measure the surface roughness. The stylus used was a standard 2011, which has 2 μm radius diamond tip. A 0.25 mm cutoff was selected to filter out low frequency signals (waviness). This is the standard cutoff wavelength for this radius stylus tip [Precision Devices, 2001]. Three measurements were taken per piece and the results were averaged. The direction of the trace was taken perpendicular to the feed, which should produce the maximum roughness. Both peak-to-valley roughness (R_z) and average roughness (R_a) results are presented.

Figure 4.8 shows the roughness values obtained from the experiment. The results show that the EDM trued wheel create slightly, less than 0.05 μm , rougher parts. The peak-to-valley results are much closer for all three wheels. Both wheels produce better surface finish as the number of ground parts increases, as shown by the downward trend of the roughness graphs. This can be attributed to a reduction in diamond height and also an increase in the wear flat on the diamond.

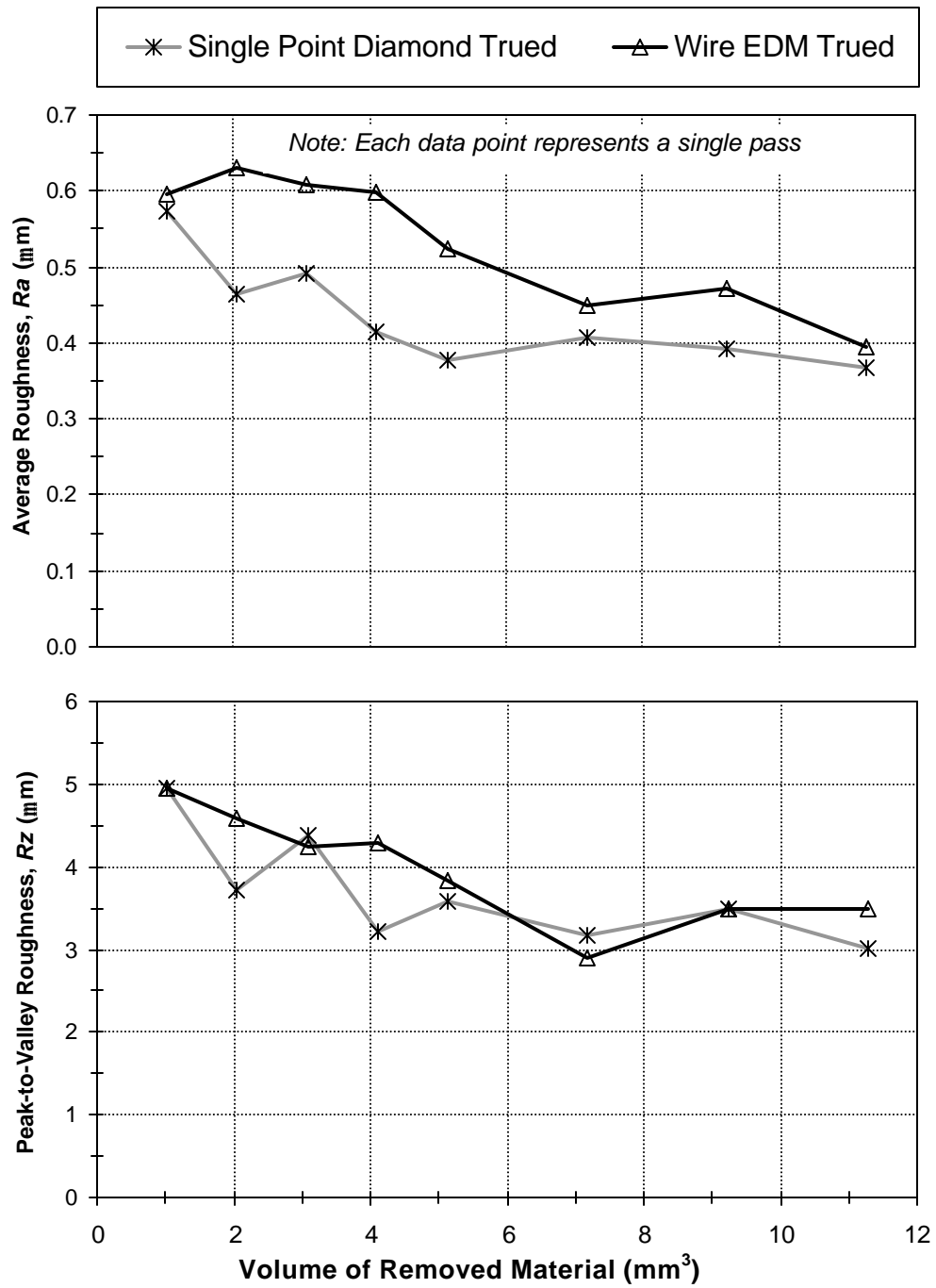


Figure 4.8: Average and Peak-to-Valley Surface Roughness Values for the Ground Silicon Nitride Samples

4.4 Wheel Wear

The final parameter which was characterized for the EDM trued wheel is the wheel wear associated with grinding. The goal of grinding is to remove unwanted material from the workpiece surface. However, in the process some material is also removed from the grinding wheel. The diamonds are worn down, sheared off, and pulled out, while the metal matrix is also worn due to friction. Wheel wear is normal, but excessive wear can cause short wheel life and loss of form tolerances.

A plastic wear block was used in this experiment in order to measure the groove created during grinding. After each pass across the silicon nitride the plastic wear block was also ground. The groove in the wheel is transferred as a step into the wear block. This step is then measured using the Rank-Taylor Hobson Talysurf machine with a 1 mm radius ball stylus.

As shown in Figure 4.9, the EDM trued wheel has high initial wear as compared to the traditionally dressed wheel. A wear depth of around 11 μm in the wheel was noted after the first pass through the silicon nitride using the wire trued wheel. While the traditionally dressed wheel showed a 5 μm wear depth after the first pass. After that initial pass both wheels seem to have a steady-state wear value of around 2 to 3 μm per pass.

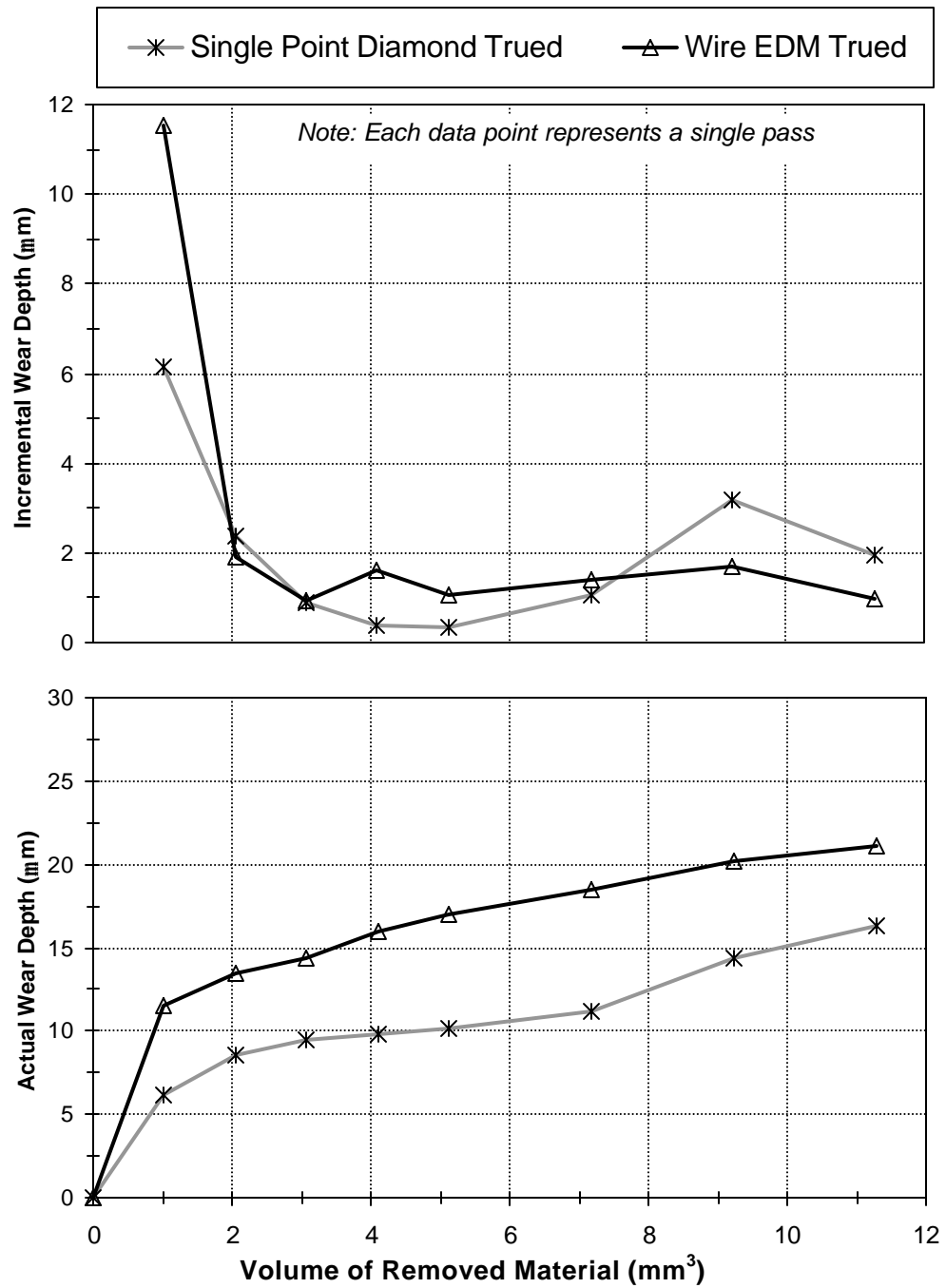


Figure 4.9: Incremental and Actual Wheel Wear Depth

What is believed to occur is shearing off of over-protruding diamonds in the EDM trued wheels. With traditional mechanical truing the diamonds and metal matrix are at the same height, then a dressing stick is used to erode the matrix, causing the diamonds to protrude. However, with EDM dressing the diamonds do not come in contact with a large mechanical force during truing. The electrical spark erodes the metal matrix, causing it to be at a constant height. Yet the diamonds are left at various heights from the metal surface. Further SEM studies will be needed to verify this theory.

4.5 Summary of Grinding Study

A 20-40% reduction in force was noted when using the EDM trued wheel as compared to the single point trued, stick dressed wheel. Wheel breakdown occurred after 6 ground parts using the stick dressed wheel. It took about 15 passes before the EDM trued wheel began to breakdown. SEM should give some insight on why the EDM wheel performed more effectively than the stick dressed wheel.

Surface finish on the ground parts were all very similar. The EDM wheel produced an average surface finish that was about 0.05 μm rougher than the stick dressed wheel. Both of the wheels produced parts with an average surface roughness below 1 μm . The peak-to-valley values were similar for both wheels at around 3-5 μm . Roughness of the ground parts decreased as the number of passes increased, as expected, due to smoothing and wear of the diamond abrasive.

The wear of the EDM trued wheel created the most concern. After only one pass the wear depth was measured to be around 11 μm for the wire trued wheel. This

was nearly double the wear of the stick dressed wheel. However, it is believed that this wear is actually the shearing off of over-protruding diamonds. Since only a small force occurs during truing, the diamonds could be over protruding. Thus, in the presence of the mechanical forces of grinding these diamonds are sheared off to desirable height. One note to remember is that the metal matrix holds the wheel form, thus diamond shearing will not affect form tolerance.

5 SCANNING ELECTRON MICROSCOPE (SEM) INVESTIGATION

The first SEM used to examine the surface of a solid specimen was described by Zworykin et al. in 1942, working in the RCA Laboratories in the United States. The electron optics of the instrument consisted of three electrostatic lenses with scan coils placed between the second and third lenses [Breton, 2001]. The electron gun was located at the bottom so the specimen chamber was at a comfortable height for the operator [Breton, 2001]. Since then, the electron microscope has become a premier tool when investigating microscopic features. Unlike the optical microscope, which uses a beam of light to reflect off the surface, SEM uses a beam of electrons that are both absorbed and reflected by the surface. The advantage of SEM includes both a high level of magnification and a large depth of field.

As mentioned previously one concern, which arose during the grinding study using the WEDT wheels, was the high initial wheel wear. A theory was developed that the diamonds on the WEDT wheel surface are over-protruding and are sheared off or pulled out by the mechanical forces of grinding. To investigate this theory, SEM was used to examine the wheel's surface. In order to determine the height of the diamonds, the Alicona stereo-SEM imaging software was used.

The first two sections of this chapter present the SEM investigation of a WEDT wheel that was used to grind silicon nitride. The third section examines the surface of a traditional stick dressed wheel. Some debris from the WEDT process is shown in section four, followed by a review of this chapter in the final section.

5.1 Setup of Study

Removal segments were cut into the wheel using a wire EDM process. The wedge shape segments are supported radially by backing screws, as shown in Figure 5.1(a), which are threaded into the grinding wheel core. By backing the screw out against the segments, the wedges are locked into place. Then WEDT process was then used to both true and dress the wheel simultaneously. Once the surface was prepared the wheel was then balanced using a balancing system and wheel weight disk. Wheel vibration could occur if this step were not taken.

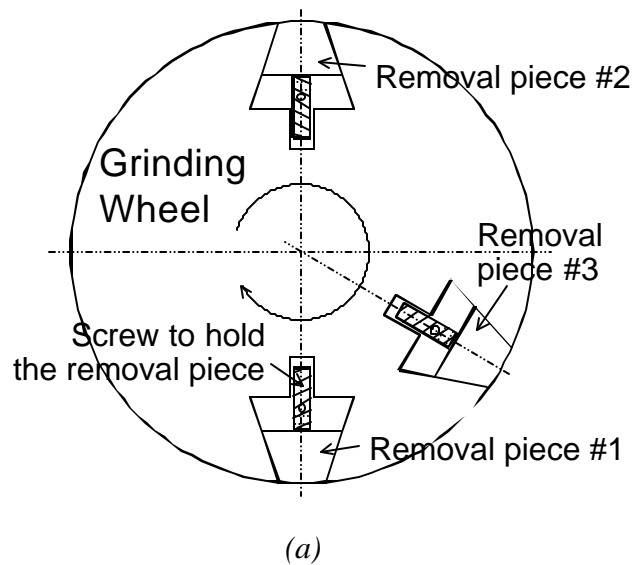


Figure 5.1: (a) Drawing of segmented wheel (b) Balancing stand

The wheel was first mounted to a balancing arbor that rest on the knife blade edges of the leveled, kinematically supported balancing stand, as shown in Figure 5.1(b). Initially, all three weights from the disk were removed and the wheel was placed onto the stand. The wheel was allowed to rotate until the heavy end rotates to the bottom, which

is then marked. One of the weights was placed at the heavy spot, while the other two were equally spaced away from the heavy spot. These two weights were then moved equally further away until the heavy spot changes. If the wheel was too far out of balance then a drill spot must be placed in the grinding wheel near the heavy spot to remove some of the weight. Once the wheel is balanced, it will roll from one end of the stand to the other without changing direction. This process is time consuming, but it assures the balance of the wheel.

Once the wheel was prepared it was time to grind the silicon nitride. The same silicon nitride tiles were used as in the previous test. However, this time they were not stacked two wide, thus a new holder was cut using wire EDM. Since the pieces are only 3.175 mm wide and the wheel is 12.7 mm wide, two depths of cut and a virgin surface could be examined. This research was conducted at Oak Ridge National Lab at the High Temperature Materials Laboratory. A Harig 618 CNC controlled surface grinder, Figure 5.2(a), was used to perform the specimen grinding preparation. Table speed was set at 3.048 m/min and wheel surface speed was set at 37 m/s.

The two total grinding depths used were 0.127 and 12.7 mm. These total depths of cuts were reached using a 0.127 mm increment of downfeed per-pass. The single pass gave data for light grinding, while the 100 passes gave data for heavy, steady state grinding. Once the grinding was completed, the specimen was removed from the wheel for SEM inspection. Visually, there was a difference between the virgin surface of the wheel and the areas that had been used for grinding. The grinding areas of the wheel appeared shiny due to the smearing of the metal matrix during grinding.

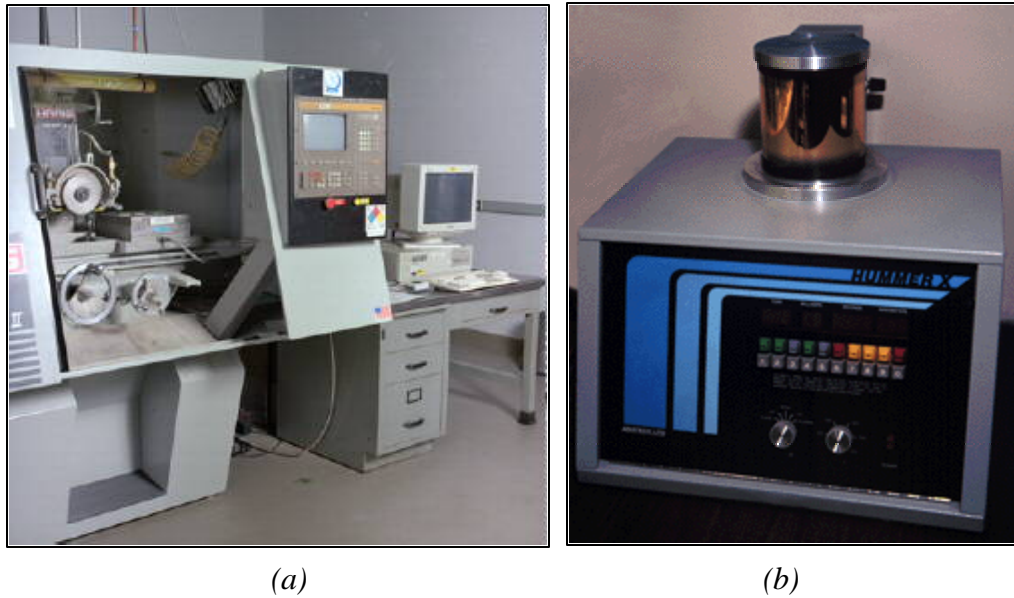


Figure 5.2: Equipment used to prepare SEM samples
(a) Harig 618 surface grinder used in experiment
(b) Hummer sputter coating machine used to gold coat the specimen

Since the SEM uses an electron beam for imaging, the surface of inspection must be electrically conductive. Since diamonds are not conductive, a thin layer of material must be placed onto the surface of the specimen. If this step were not taken, a charge would build up on the surface of the diamonds, creating a white spot in the image. In order to coat the specimen, it first had to be cleaned by placing it into an acetone bath within an ultrasonic cleaner. This vibrates the bath to remove the oils and resin left behind by grinding and handling.

Figure 5.2(b) shows the sputter coating machine used to coat the specimen with gold. The specimen is placed inside the chamber then it is evacuated and filled with Argon. A high voltage is applied between the source (gold) and the target (specimen).

The excited electrons then bounce off the source onto the target discharging small gold particles from the gold source, which then adhere to the surface of the specimen. This coating is very thin and uniform. Once the specimen was cleaned and coated, it was ready to be viewed under SEM.

5.2 SEM Results of WEDT Wheel Surface

The SEM used was a Hiatchi S-4700 field emission scanning electron microscope. This was selected due to the automated stage positioning and tilting features, which is required for constructing a 3-D image of the surface. Stereo-SEM can quantify the height of features from SEM. In order to do so, an image of the surface is first taken with the stage set at 0° tilt. Then a feature is marked on the screen image that can be relocated again once the table was tilted. Once identified, the stage is tilted a specified angle, 2° in this study. Then the stage is translated to bring the original marked feature back into view. By knowing the working distance and pixel size, the two images can be combined using Alicona 3-D imaging software. After the stereo-pair was created a 3-D image of the surface was generated.

5.2.1 Virgin WEDT Wheel Surface

The surface of the WEDT wheel after truing is shown in Figure 5.3. There is a good amount of material that has resolidified to the surface of the wheel. The debris adhered to surface comes from two sources. The first source is the molten spheres which did not escape the gap during spark erosion, or where impelled back to the surface by the

water jet. Figures 5.3(b) 5.3(c) show what the resolidified spheres look like on the wheel surface. Another source of recast debris is from the collision of the metal spheres with diamonds at the surface. The diamonds are non-conductive, however, EDM sparking is occurring all around them removing the bonding metal. As described in the Introduction section of this report, the molten spheres are abruptly expelled from the surface. When these spheres collide with the diamond the molten spheres explode, and splash on their surroundings, as shown in Figures 5.3(a) and 5.3(e). Notice that in Figure 5.3(e) it appears this process has occurred many times, causing a layering effect.

A sense for some relative diamond height can be seen also in the SEM scans. The diamond in Figure 5.3(a) seems to be merely laying on the surface, while in Figure 5.3(d) the diamonds seem to be recessed into the metal surface. In a traditional mechanically trued wheel, the diamonds on the surface would be at the same height. This is because mechanical forces between the wheel and dressing tool would have sheared off the diamonds. However, since no real mechanical forces are applied in WEDT, the diamonds can protrude for a large distances until they fall away from the surface. Diamond distribution in the wheel is fairly consistent, thus there should be equal amounts of diamond protruding at different heights from the matrix.

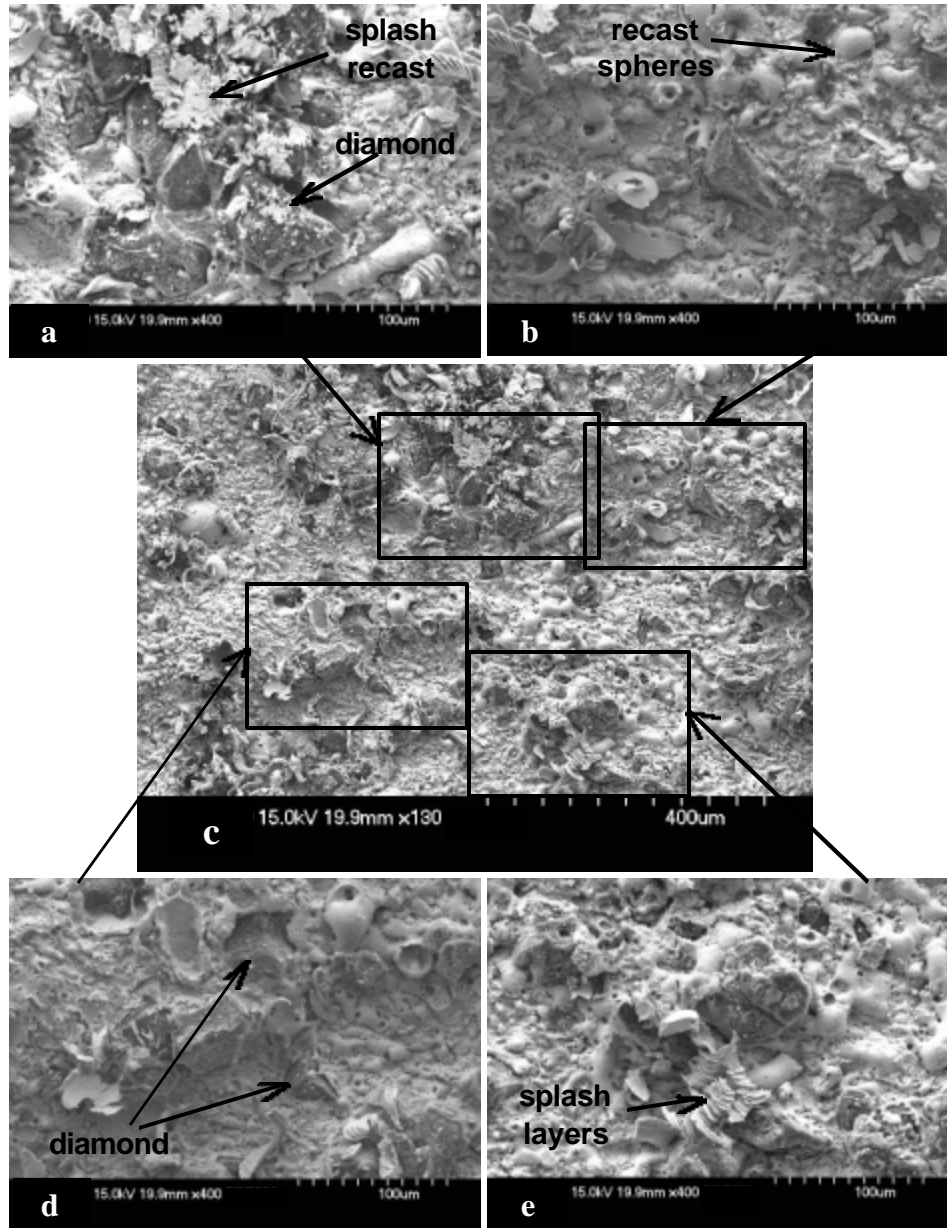


Figure 5.3: SEM scans of the virgin WEDT wheel surface

In order to determine the actual protrusion height of the diamonds, a 3-D image of the surface was rendered as described previously. This software allows two types of output. One is simply a 3-D image of the surface and the other is a 2D image in which you choose a path to have it graph elevation. Figure 5.5 shows a diamond which was noted previously, as merely laying on the surface. By using the elevation graphing feature in the imaging software, the actual height of the diamond from the surrounding matrix is about 29 μm . Another diamond is shown in Figure 5.6 as protruding from the surface about 32 μm . For a 320 grit abrasive, the average abrasive size is about 60 μm . Thus, some of the diamonds on the WEDT surface are protruding half of their magnitude, from the matrix. The gap between the wire and the grinding wheel during WEDT is about 40 μm , as shown in Figure 5.4. This clearance allows adequate space for the 60 μm

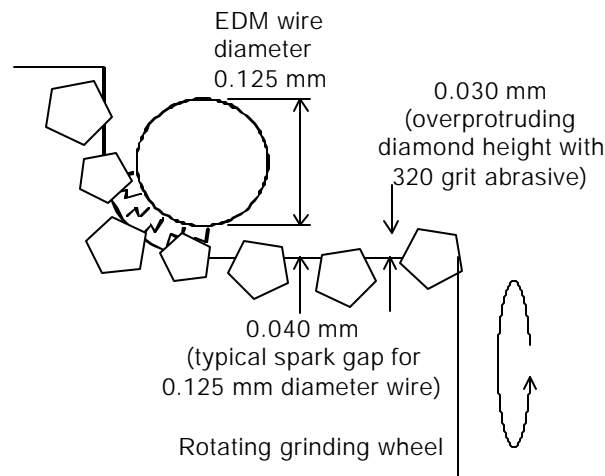


Figure 5.4: A 40 μm gap clearance in WEDT process allows 30 μm diamond protrusion

diamonds to protrude with abrading the wire. Some of the diamonds measured were only protruding 6-8 μm , while others such as the diamond in Figure 5.7 measured around 10-

12 μm of protrusion. Thus diamond protrusion on the virgin WEDT wheel surface was equally distributed up to about 30 μm .

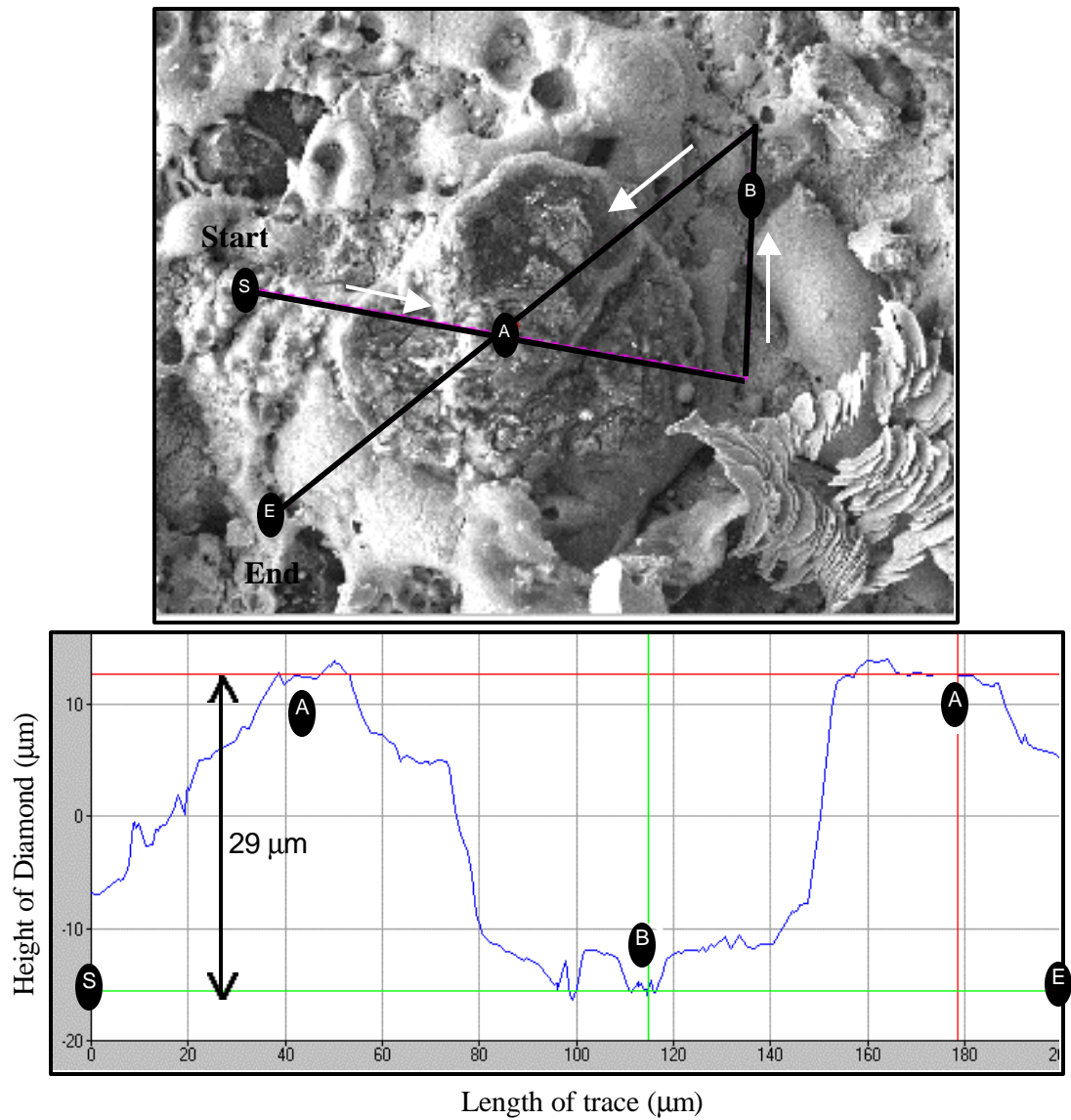


Figure 5.5: Stereo-SEM profile of WEDT virgin wheel surface with 29 μm protruding diamond

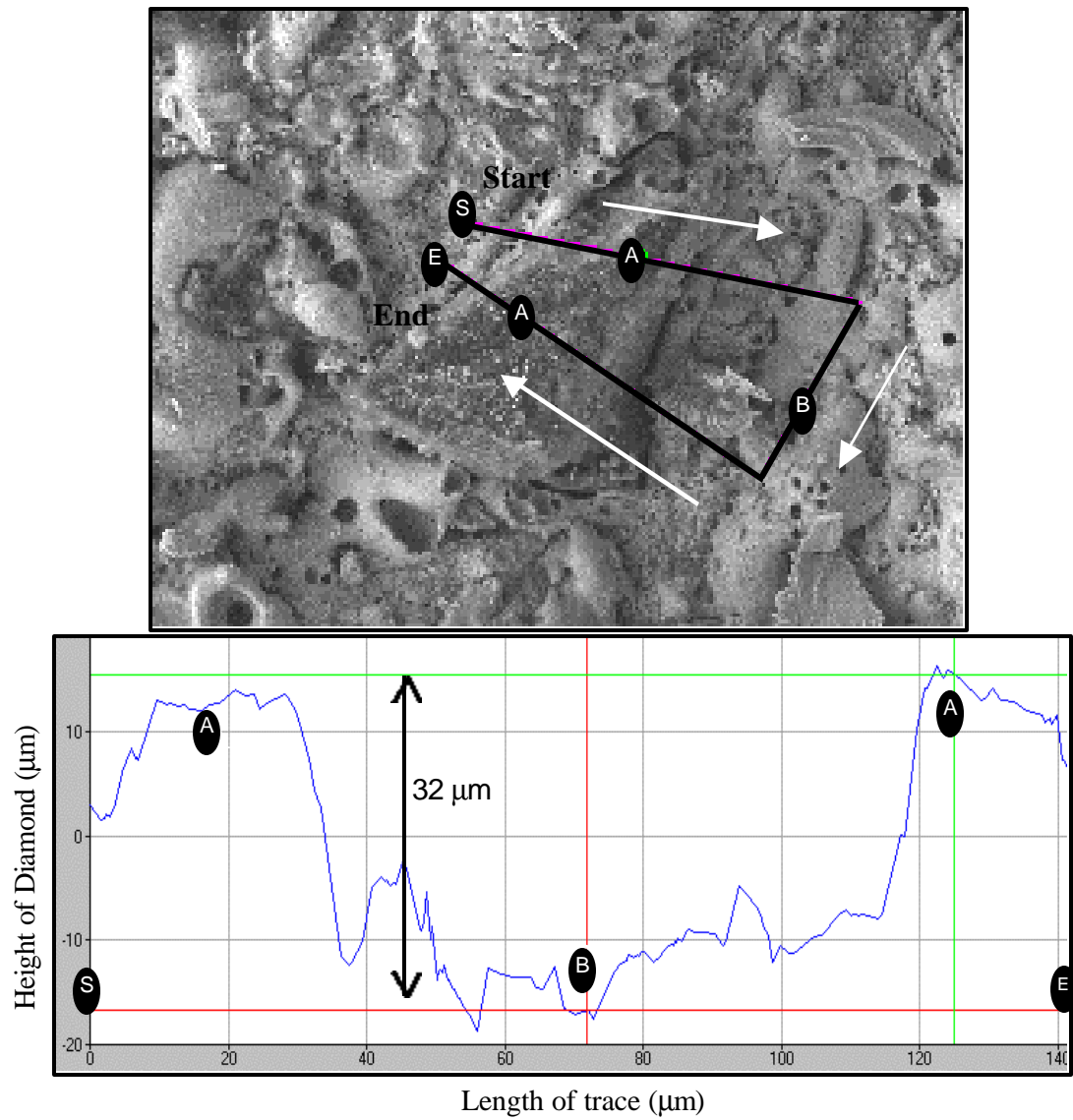


Figure 5.6: Stereo-SEM profile of WEDT virgin surface with 32 μm protruding diamond

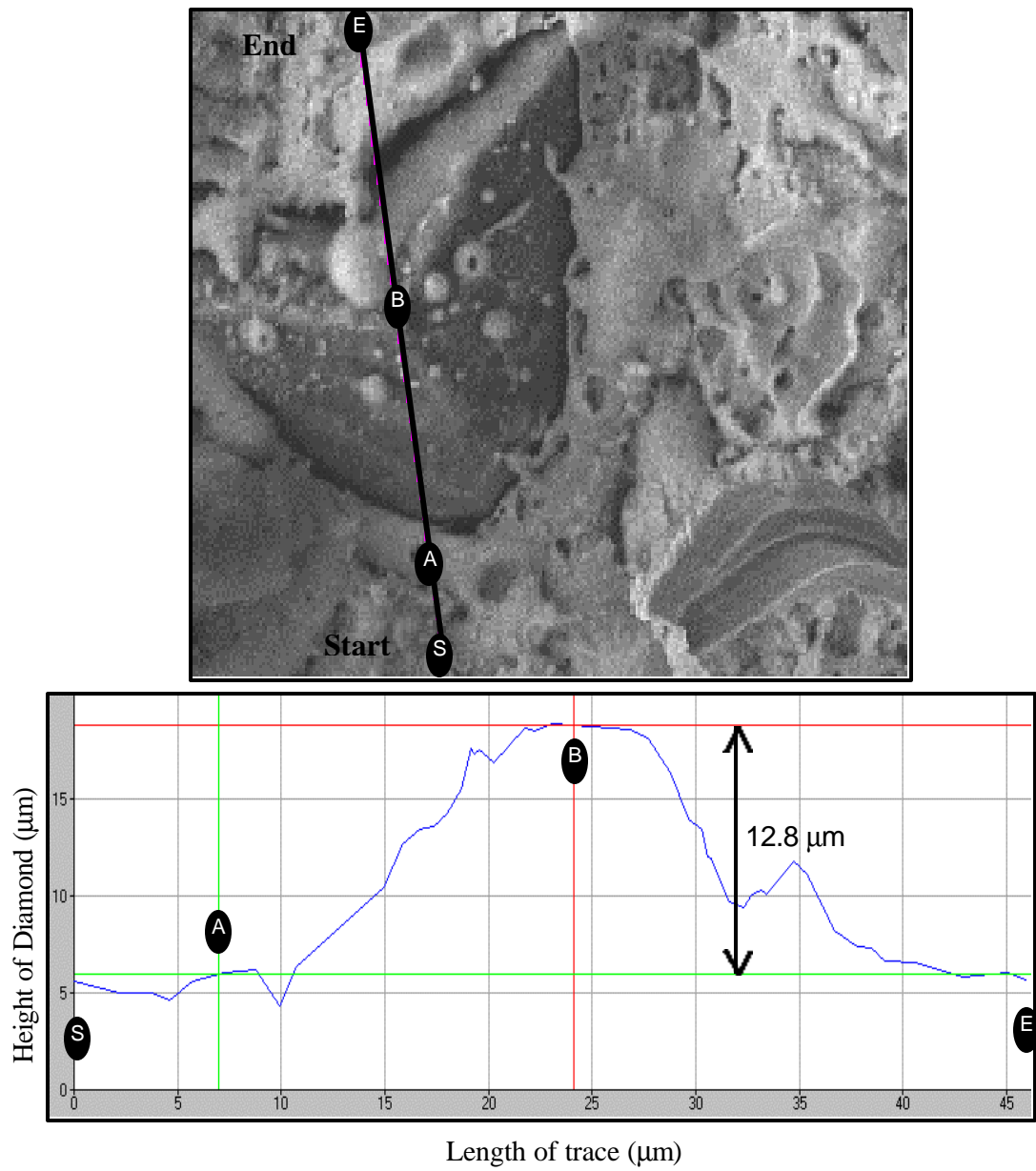


Figure 5.7: Stereo-SEM profile of WEDT virgin wheel surface with 12.8 μm protruding diamond

5.2.2 WEDT Surface After Light Grinding

By examining such a light-grinding pass, the change in surface topography of the wheel can be seen after only a slight presence of a mechanical force. This is important to see what happens to those diamonds that were overprotruding in the virgin wheel. Figure 5.8 shows a section of the surface of the wheel after the 0.127 mm depth of cut.

There is a large amount of the debris that has been removed from the surface. This material is only weakly bonded to the surface, thus is removed during the initial contact with the workpiece. This is acceptable since the true WEDT form is under the recast. Both Figures 5.8(a) and 5.8(b) show some diamonds that have been sheared off by the mechanical force. The flat planes and sharp edges of the diamonds prove that these diamonds have sheared.

Figure 5.8(b) shows a smooth metal surface, which appears to be too large to come from diamond pullout. It could have been created by the sheared diamond just to the right of the area being dragged over the surface. There is no evidence in the scans of a large amount of diamond pullout. It appears that most of the diamonds have sheared under the load of the mechanical force. The diamond in Figure 5.8(e) appears to be an active grinding grain, evident by the rub mark on the top of the diamond. However, the diamond does not show signs of being sheared. Thus, this diamond must have been at a protrusion height capable of supporting the grinding load.

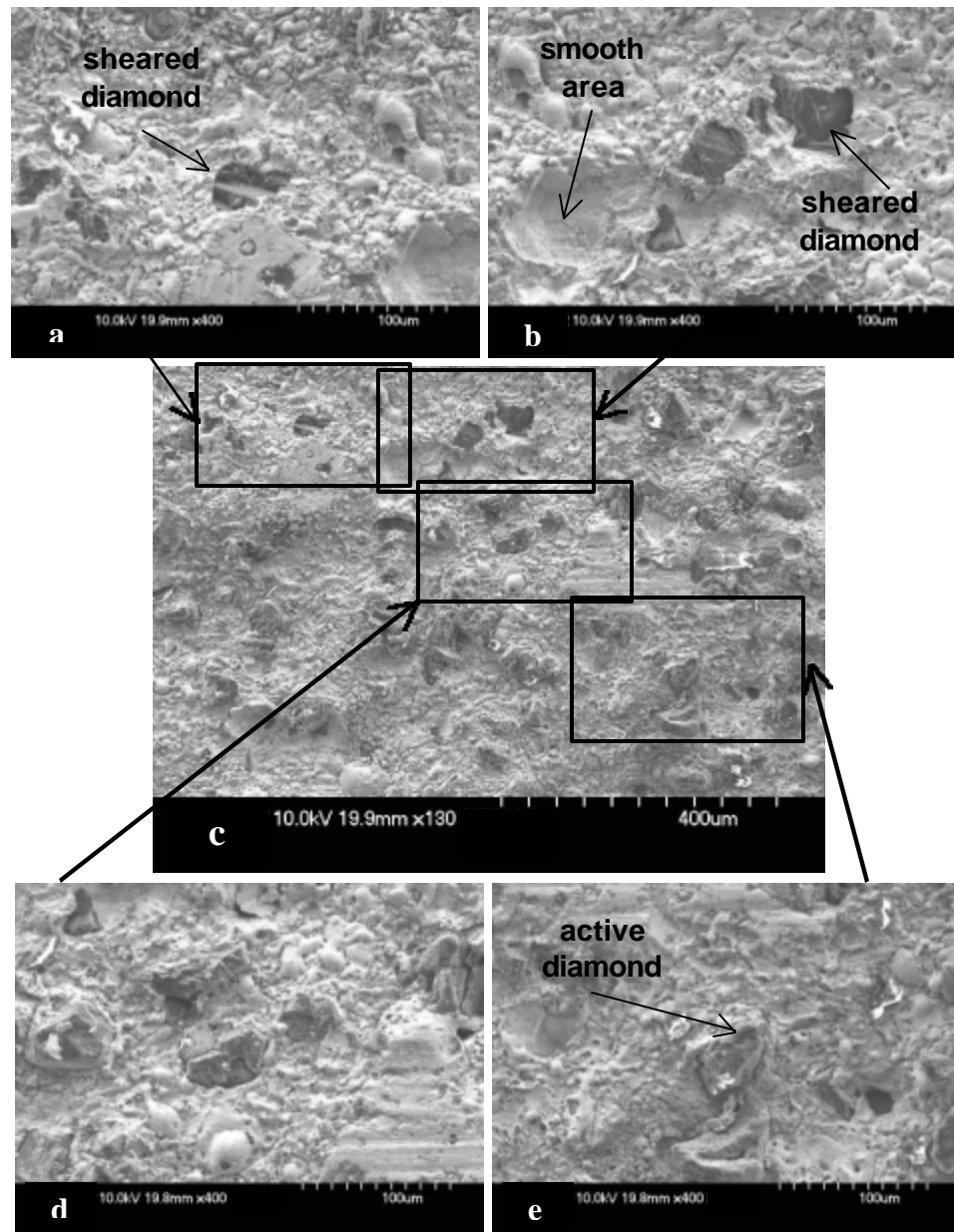


Figure 5.8: SEM scans of the wheel surface after light-grinding

Using the 3-D imaging software the actual heights of the diamonds were found. In order to keep the diamond height values consistent, a reference height was set as the smeared metal working surface, shown in Figure 5.10. All diamonds at this height or above are considered active grinding grains. Thus, all diamond heights will be measured from this working plane. Figure 5.10 shows a diamond that is protruding about 6 μm at location C, while a diamond at location B is at the same height as the working surface. Both of these diamonds are active as evident by the rub marks on their surface.

Figure 5.11 shows that the diamond from Figure 5.8(e) is at the same height as the work surface. Chip clearance around the diamond was measured as about 12 μm . All of the diamonds measured from this lightly ground section showed protrusions less than 10 μm from the working surface. None of the diamonds were the 30 to 40 μm protrusions seen in the virgin surface, due to diamond shearing.

In the presence of a large mechanical force, such as during grinding, these over-protruding are sheared off. Figure 5.9 shows the silicon nitride workpiece shears off the over-protruding diamonds, leaving the diamonds on the unground surface overprotruding. The forces generated when transferring this step into the plastic wear block are not great enough to shear off all the overprotruding diamonds, creating a large initial step in the block. This would create what appears to be high initial wear, but is only the shearing off of over-protruding diamonds. It is important to remember that any form placed into the wheel would be in the metal matrix, thus form tolerance is preserved.

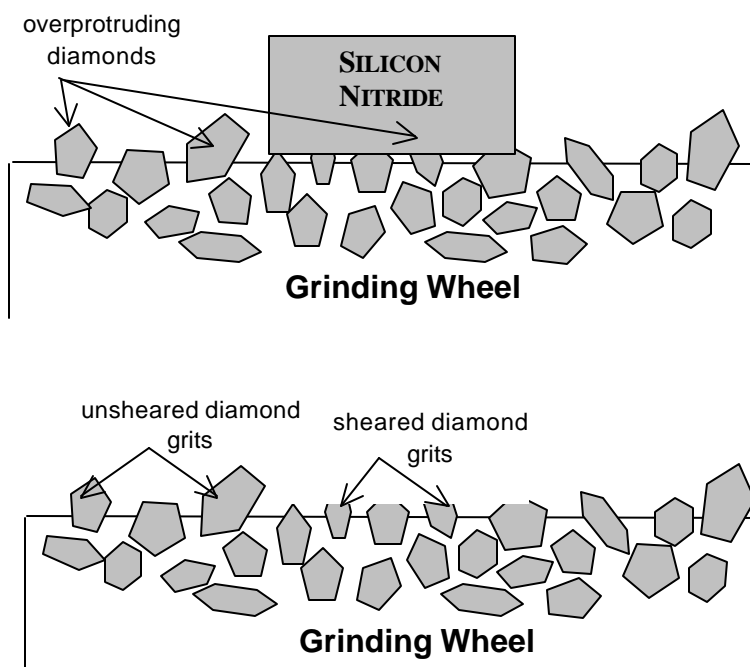


Figure 5.9: Diagram of diamonds sheared during grinding

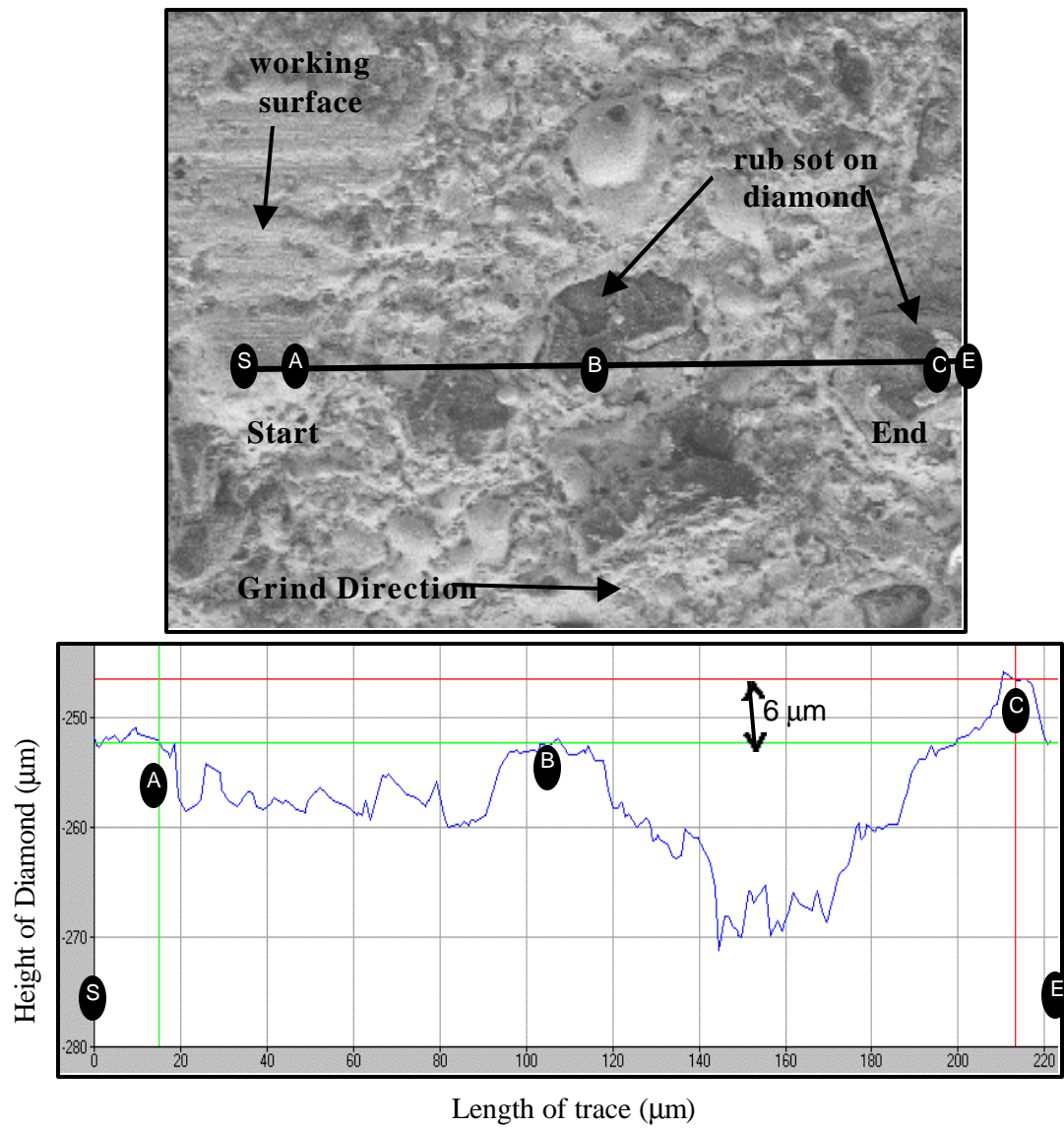


Figure 5.10: Stereo-SEM profiles of lightly ground surface with 6 μm protruding diamond

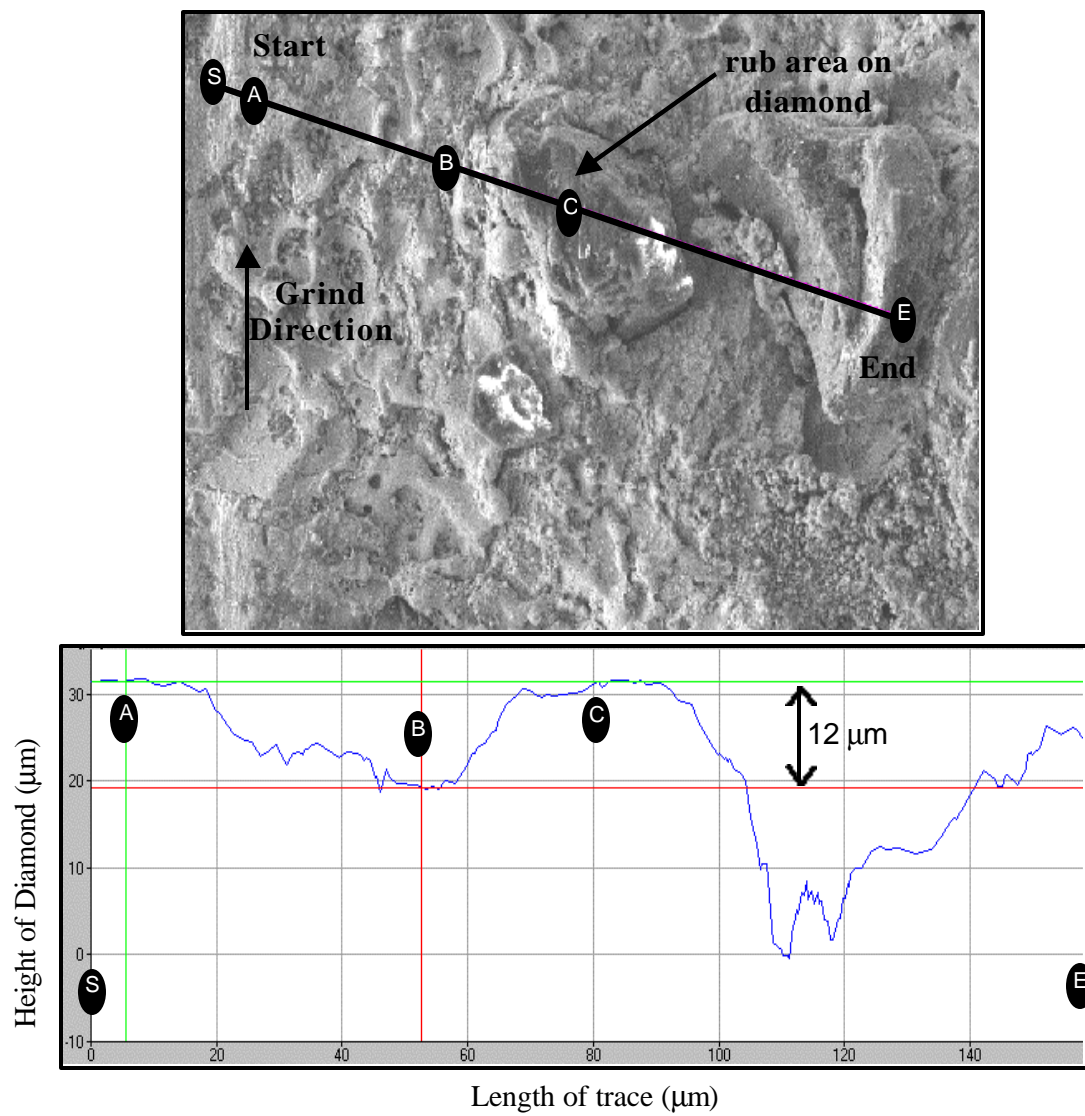


Figure 5.11: Stereo-SEM profiles of lightly ground surface with 12 μm chip clearance

5.2.3 WEDT Surface After Heavy Grinding

In order to see measure the diamond height at steady-state grinding, the wheel surface was analyzed after extensive grinding. Figure 5.13 shows the post grinding wheel surface. The amount of smeared work surface and diamond shearing has increased dramatically from the light ground surface. Figures 5.14 and 5.15 show that the diamond height is varying from 13 to 4 μm . The diamond in Figure 5.14 at location B is peaking at around 8 to 13 μm . The deep grooves created in the work surface makes the diamond height measurement a little more difficult to decipher. This diamond is getting near a height were it could be sheared by the grinding load.

The diamond in Figure 5.15, at location B, is protruding about 5 μm from the work surface. However, the more interesting feature is the 4 μm cavity that has been created in front of the diamond. During continuous grinding, chips begin to erode away the matrix just in front of active abrasive grains, as shown in Figure 5.12. Much like a chip in metal machining will erode the work face of a single point tool. The silicon

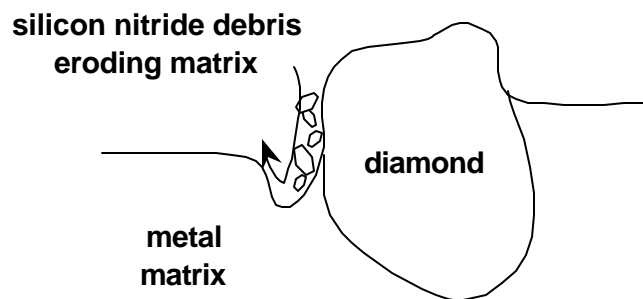


Figure 5.12: Mechanism that creates the wear cavity in front of the diamond face

nitride debris slides down the face of the diamond, forcing the erosion of a cavity in front of the diamond generating chip clearance.

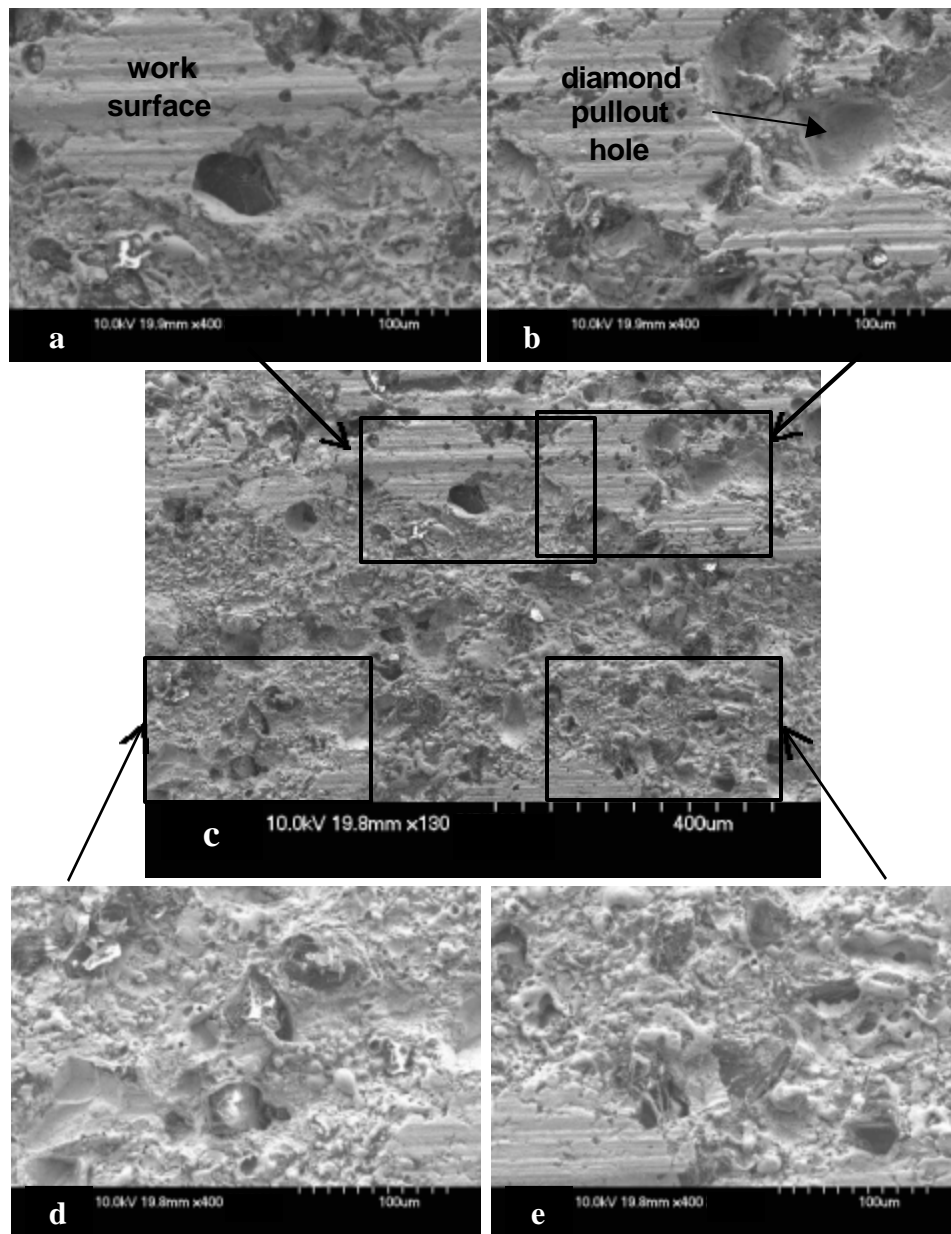


Figure 5.13: SEM scans of the wheel surface after heavy grinding

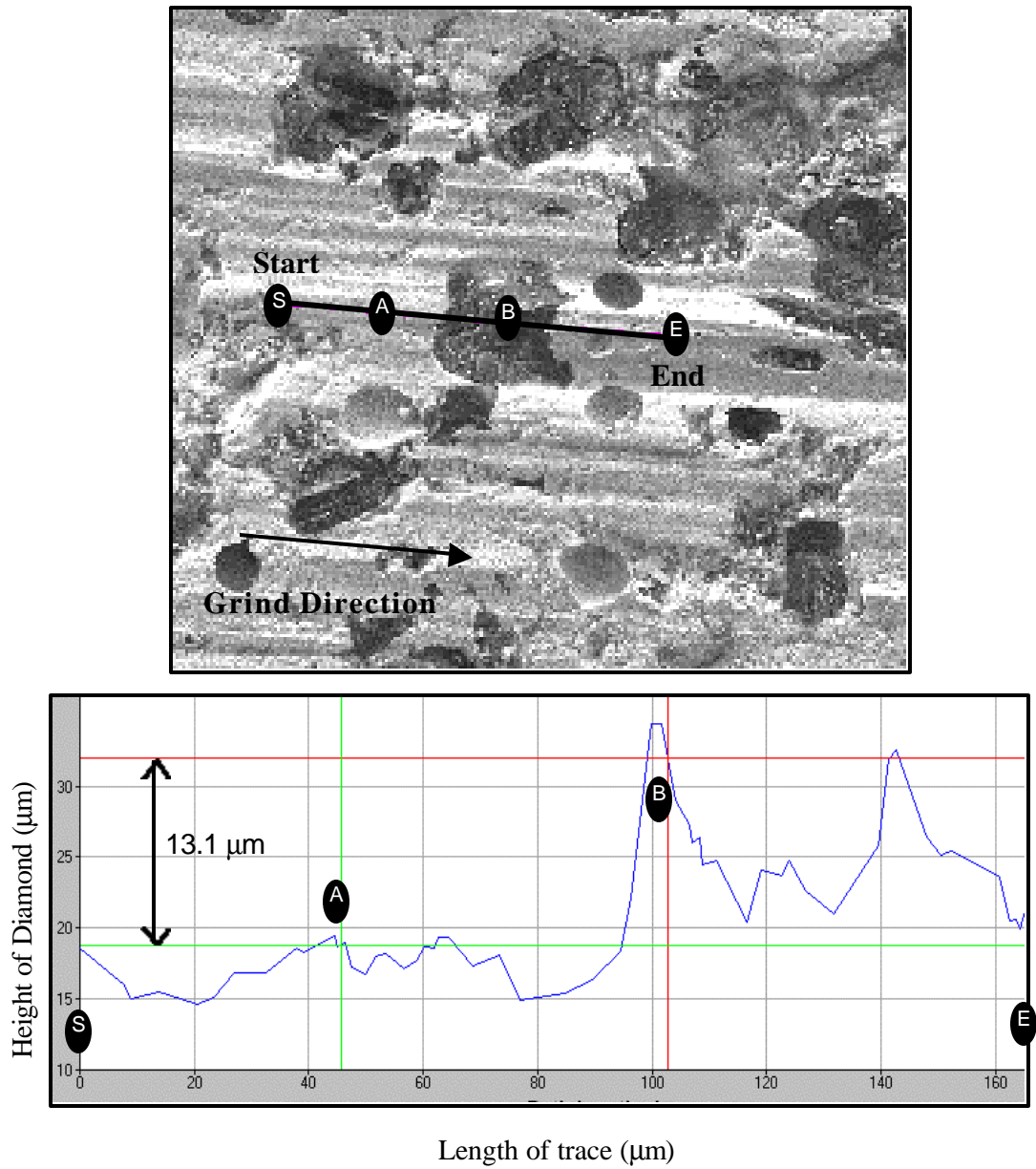


Figure 5.14: Stereo-SEM profiles of heavy ground wheel surface with 13 μm protruding diamond

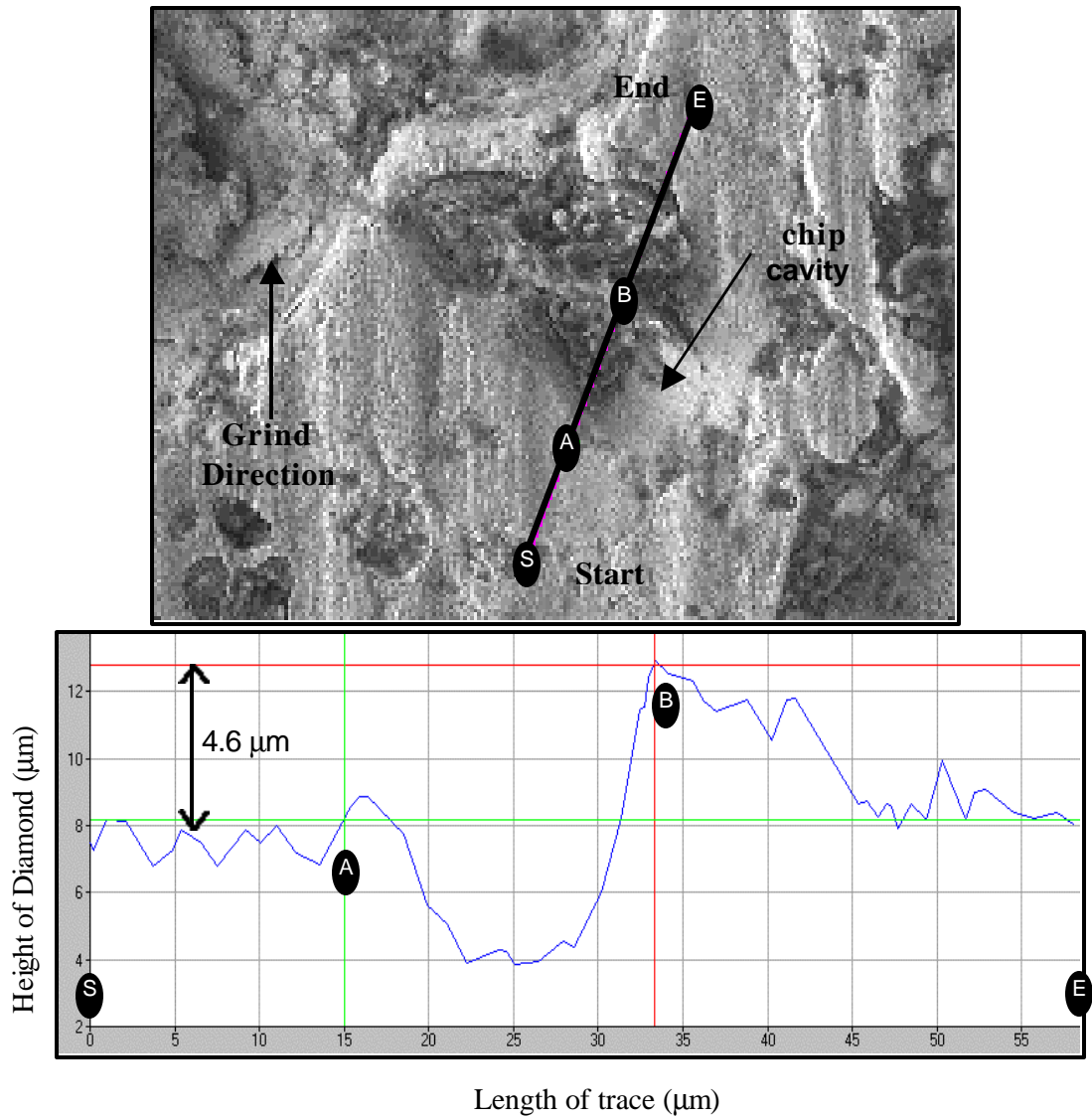


Figure 5.15: Stereo-SEM profiles of heavy ground surface with 4.6 μm protruding diamond and wear cavity

5.3 SEM Results of Stick Dressed Wheel Surface

The traditional way to dress a metal bond diamond wheel is to use a dressing stick. A single point diamond or a rotary truing device can be used to true the wheel. Since this study uses a flat wheel surface, it is possible to use a rotary truing method, as shown in Figure 5.16(a). A Norton Rotary dresser was used to true the wheel, with a SD150R100B99 1/4" diamond wheel. The small truing wheel was turning at 3450rpm



(a) (b)
Figure 5.16: (a) Rotary truing unit using a MBD wheel to dress the MBD wheel (b) SEM scan of the flat trued surface

while the study wheel was turning at 3000 rpm. The wheel was feed down at 25.4 μm per pass, with a total downfeed of 1.524 mm. Of course, in this case both the truing and study wheels lose material since they are of similar hardness. The diamonds and the metal matrix of the study wheel appeared to be at the same height under in the SEM scan, as shown in Figure 5.16(b)

Once the wheel was trued it was time to dress the wheel using a silicon carbide dressing stick. Both a fine 400 grit and a rough 150 grit stone were used to dress a portion of the wheel. During truing, a total of 7.74 cm²/unit width of dressing stick was consumed. After comparing the differences in the dressed surfaces, no noticeable difference was found. Therefore the distinction between the two surfaces will not be stated, it will simply be referred to as the stick dressed surfaced. Figure 5.17 shows the SEM scans of the stick dressed surface, notice the relatively clean surface of the wheel, as compared to the WEDT wheel.

Due to the use of the mechanical force during truing, the diamonds and matrix were on the same plane. Then the stick was used only to create a chip clearance around the diamonds. The silicon carbide stick is strong enough to erode the metal matrix, but not the diamond. Thus after dressing, the diamonds will be protruding a certain distance from the surface.

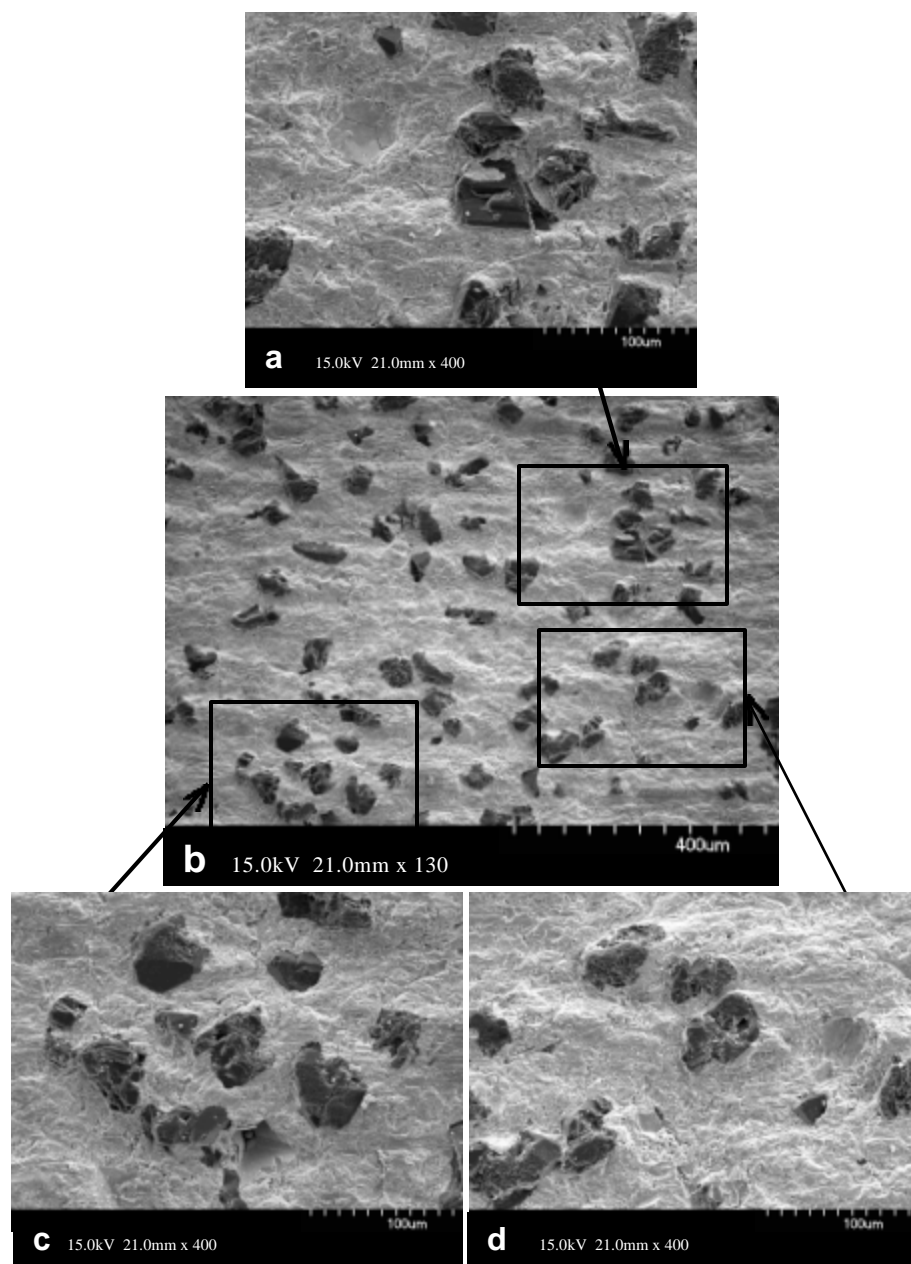


Figure 5.17: SEM scans of 400 grit silicon carbide stick dressed wheel surface

Figure 5.19 shows two diamonds that are protruding 12 μm from the matrix. The diamonds in Figures 5.20 and 5.21 are protruding about 7 μm . The range for diamond height for the stick dressed surface was 6-12 μm . The difference in the diamond heights is due to an uneven wear of the metal matrix. A wear cavity is also noted in Figure 5.20 due to dressing stick debris sliding down the face of the diamond, eroding the matrix away in front of the diamond.

Another feature in Figure 5.21 is the ridge that is created behind the diamond. As the stick is passing through the diamond erodes the dressing stick, before it can wear the metal away just behind the diamond. As shown in Figure 5.18, maximum diamond clearance is in front of the diamond due to the cavity that is created. To the left and right of the diamond good clearance is also created. However, just behind the diamond the amount of chip clearance is limited due to dressing stick wear.

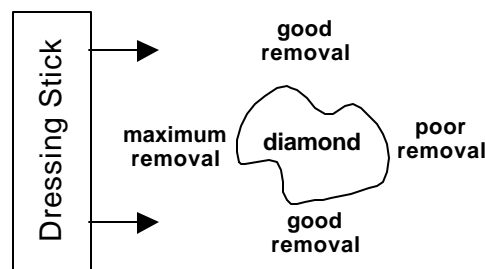


Figure 5.18: Description of dressing material removal zones

Whether these ridges are a good or bad phenomena is debatable. One positive is that this ridge can help support the diamond as it is loaded from the front by contact with the workpiece. One negative is the reduced chip clearance, which is believed to be the

reason for the 20% increases in grinding force when using the stick dressed wheel over the WEDT wheel.

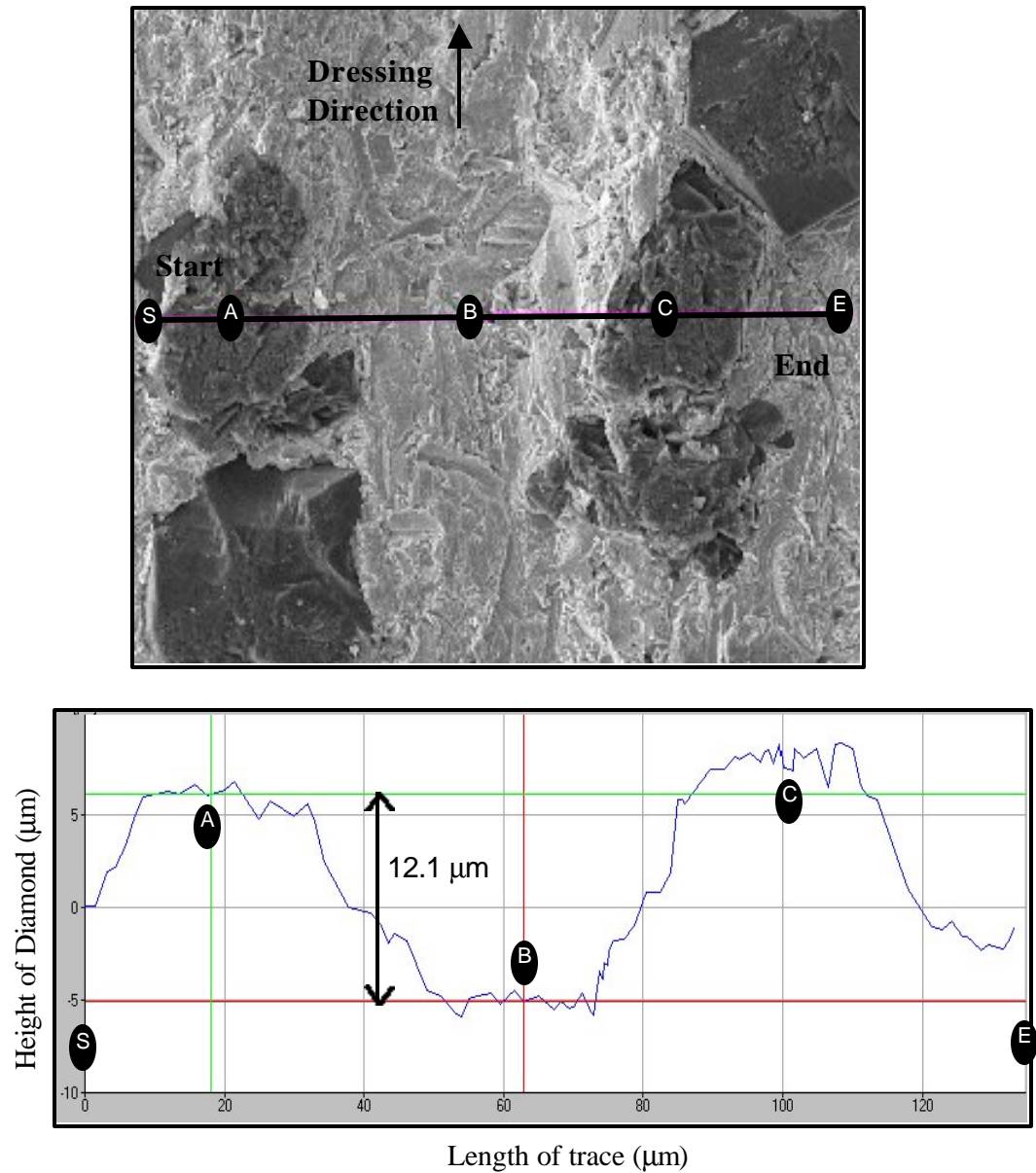


Figure 5.19: Stereo-SEM profiles of stick dressed surface with a 12 mm protruding diamond

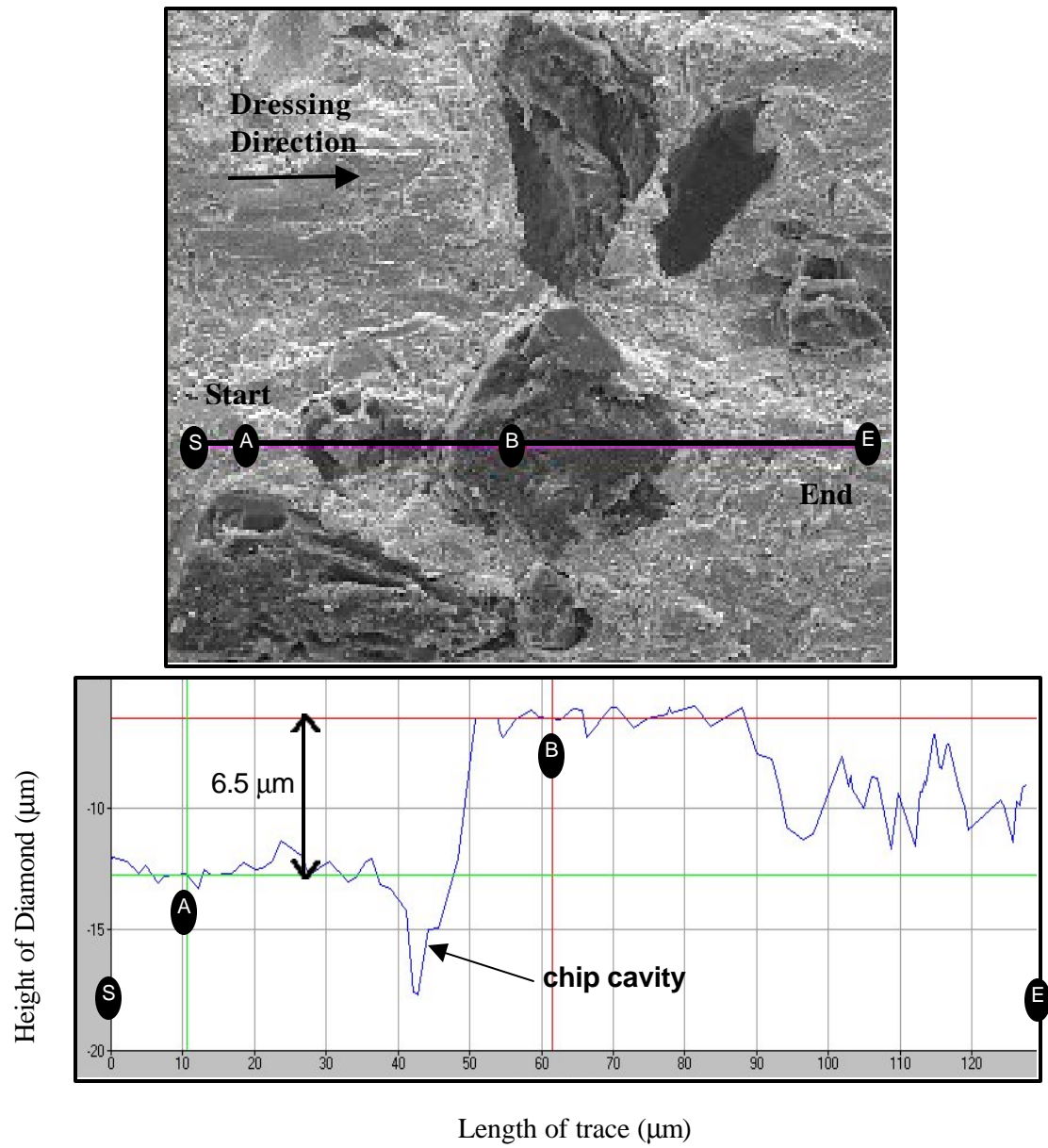


Figure 5.20: Stereo-SEM profiles of stick dressed surface with a 6.5 mm protruding diamond

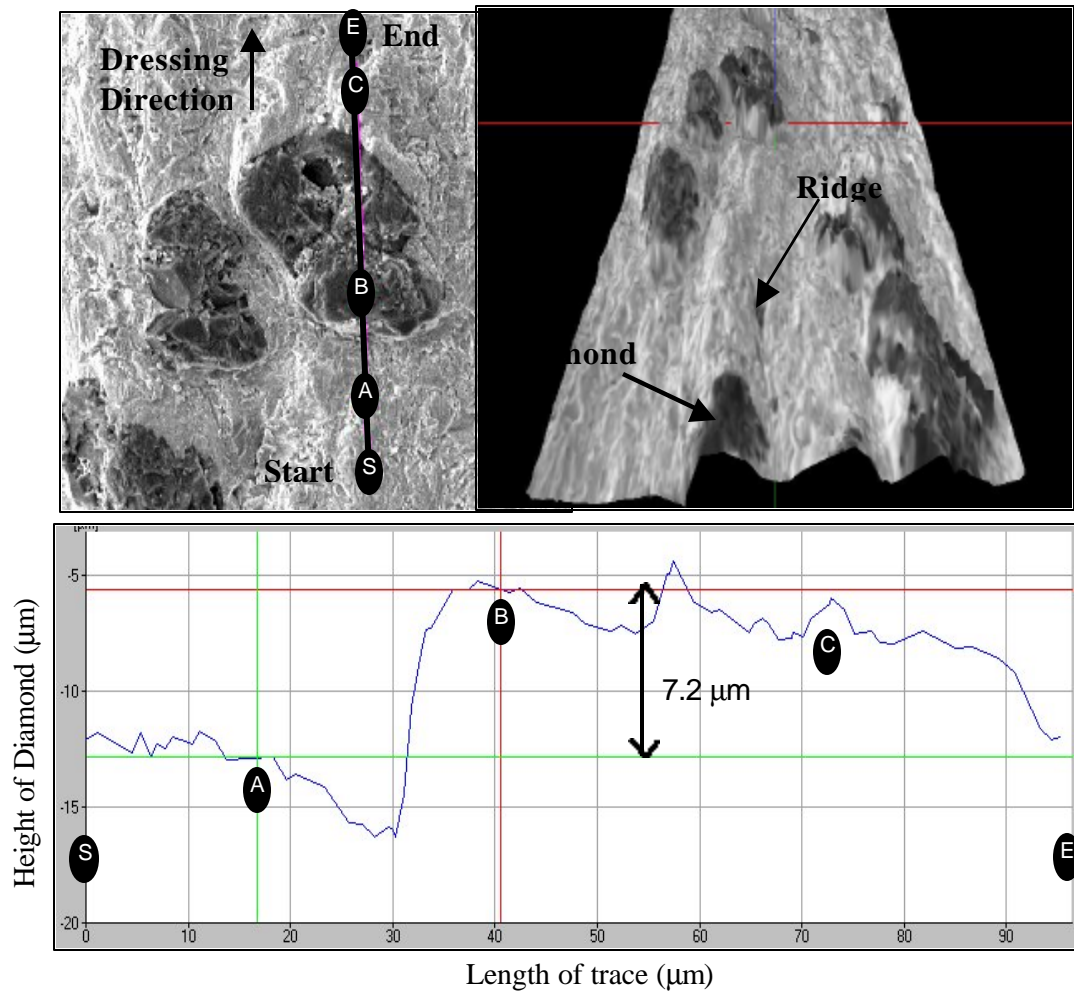


Figure 5.21: Stereo-SEM profiles of stick dressed surface with a 7 mm protruding diamond and ridge

5.4 WEDT captured debris

During the truing process, some of the debris was captured in order to view in SEM, shown below. The 60 μm diamonds are much more visible in the debris than on the surface of the wheel. Some of the spherical metal debris was also captured, as shown in Figure 5.22. These metal spheres have good shape, which implies that they received good flushing during their resolidification process.

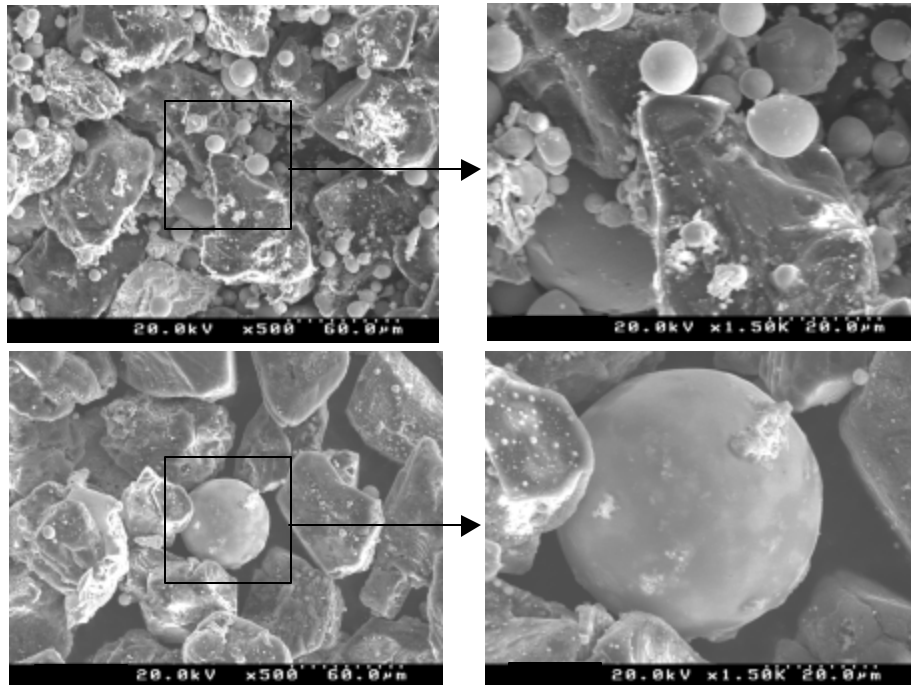


Figure 5.22: WEDT swarf from the truing of a Scepter 320 grit diamond wheel

5.5 Conclusion of SEM investigation

For the WEDT surface there was evidence to show that some of the molten metal spheres had adhered back to the surface of the wheel. The height of the diamonds on the virgin surface varied from 3 to 35 μm . When a light grind was used, the diamonds were all protruding less than 13 μm from the work surface. At the large grinding depth, the diamonds were protruding 4 to 13 μm from the working surface. Due to the number of sheared diamonds, the theory for high initial wear due to shearing of overprotruding diamonds is proven.

Contrary to the rough surface of the WEDT wheel, the surface on the rotary diamond trued and silicon carbide stick dressed wheel was smooth. The range of diamond heights from this surface ranged from 6 to 10 μm . Two demographic features noted about the surface, are the ridge created behind the diamond and the cavity created in front of the diamond face. The ridge, while it supports the diamond during force loading, also reduces the amount of chip clearance. This is thought to be the reason why the WEDT wheel grinds more freely than does the stick dressed wheel.

The major problem with rotary dressing is its inability to create a formed profile in the wheel. In order to create a profile in a wheel surface a single point CNC controlled diamond or a diamond crush roll must be used. As mentioned previously, neither of these methods are effective for creating precision forms due to truing tool wear.

6 CONCLUSION

As the applications of engineering ceramics broadened, the shape of these components has become more complicated and the form tolerance specifications are more stringent. An efficient and cost-effective method to grind a ceramic component with a complicated shape is to generate the desired form on a diamond grinding wheel and then plunge the shaped wheel into the ceramic workpiece. The excess ceramic work-material is removed by the diamond grinding wheel, and the desired form is generated on the workpiece. Based on this approach, the technical challenge has shifted from grinding the workpiece to truing and dressing the diamond grinding wheel.

Traditionally, a stationary or rotary diamond tool is used to generate the desired form in a grinding wheel. Shih [2000] has studied the wear of the rotary diamond tool for truing of a vitreous bond diamond grinding wheel and demonstrated that the wear of diamond tool is significant under a wide range of process parameters. Instead of using mechanical force to break the diamond, the wire EDM process uses the thermal energy or electrical sparks between a thin, traveling wire and the rotating grinding wheel to remove the metal bond around the non-conductive diamond abrasive. The Japanese patents by Mizukawa [1992], Shichizawa [1993], and Oku [1984] all use rotary die sinking EDM truing methods. However, not much work has been focused on creating precise wheel forms, which was at the core of this investigation.

The begin the research, a precision spindle was built to rotate the grinding wheel inside the EDM machine during truing. The spindle had to endure the corrosive and high electrical flow environments of the EDM process. In addition, the spindle was desired to

have sub- μm runout and also to be capable of incorporating various wheel sizes. The final design met all of the criteria and achieved a spindle runout of $0.6\ \mu\text{m}$.

Two formed wheel geometries were then adopted in order to determine the abilities of Wire Electrical Discharge Truing (WEDT). A peak-valley profile was implemented to determine the minimal inner and outer part radii that could be achieved. The minimum peak radius for a part was about $108\ \mu\text{m}$, while $82\ \mu\text{m}$ was the minimum radius for a valley in the component. The form error capability of the WEDT procedure was determined using an arc profile. Two cutoff values, 0.08 and $0.25\ \text{mm}$, were used to filter the trace data, which gave form error results of 6.5 and $2.4\ \mu\text{m}$, respectively.

To determine the performance of the WEDT wheel, a grinding study was developed. Force and power during grinding was collected using a Hall-effect power sensor, a force dynamometer, and a data acquisition system. A plastic wear block was used to quantify the progressive wheel wear. The ground ceramic tiles were used to quantify surface roughness trends. The test included two truing methods for comparison. One of the wheels was trued using a single point diamond, while the WEDT process presented in this report trued the other wheel. The WEDT wheel required no additional preparation, since the EDM process completes both truing and dressing simultaneously. The single point trued wheel was dressed with a silicon carbide stick to create chip clearance.

The forces generated during grinding with the WEDT wheel were 20-40% lower than the forces produced when grinding with the single point trued, stick dressed wheel. Wheel breakdown occurred after 6 ground parts using the stick dressed wheel. It took

about 15 passes before the EDM trued wheel began to breakdown. Surface finish on the ground parts were all very similar for both truing methods. The average surface roughness results were below 1 μm , while the peak-to-valley results ranged from 3-5 μm . Roughness of the ground parts decreased as the number of passes increased as expected, due to an increase in the diamond wear flats. The high initial wear of the EDM trued wheel created the most concern. After the initial grinding pass, the wheel wear stabilized to around 2 $\mu\text{m/pass}$. Scanning Electron Microscopy (SEM) was required to investigate theories behind this decrease in force and increase in wheel wear when grinding with an EDM trued wheel.

In the SEM scans, there was evidence to show that some of the molten metal spheres had adhered back to the surface of the WEDT wheel. The height of the diamonds on the virgin surface varied from 3 to 35 μm . When a light grind was used, the diamonds were all protruding less than 13 μm from the work surface. At steady-state grinding, the diamonds were protruding 4 to 13 μm from the working surface. This led to the conclusion that the diamonds in the virgin WEDT wheel surface are overprotruding. Thus, in the presence of a sufficient mechanical force they will shear. There was plenty of sheared diamond surfaces in the lightly ground SEM scans to prove this theory. However, the form has been placed in the metal matrix, thus shearing of overprotruding diamonds does not effect the form tolerance.

Also at steady state grinding, 4 to 5 μm cavities were found in front of the diamond faces. The grinding debris creates these cavities as it slides down the face of the diamond, eroding the matrix just preceding the diamond. Contrary to the rough surface

of the WEDT wheel, the surface on the diamond trued and silicon carbide stick dressed wheel was smooth. The range of diamond heights from this surface ranged from 6 to 10 μm . Two demographic features noted about the surface were the ridges created behind the diamonds and the cavities created in front of the diamond faces. As the dressing stick passes over the diamond, the stick becomes worn. Therefore, the dressing stick does not remove the metal just behind the diamond. This reduction in chip clearance and extreme diamond protrusion is believed to be the reason for the reduced grinding forces of the WEDT wheel.

In this study, WEDT has proven its ability to produce precise forms in metal bond diamond wheels. In grinding, WEDT wheels also showed a decrease in grinding force, as well as an increase in the dressing interval. Through the use of an electrical spark instead of a mechanical force, the wheels can be trued/dressed without concerns of truing tool wear. This wheel forming technology should serve even more valuable to the machining community as the number of ceramics in engineering design increases.

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